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Notices

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What is in this guide

This user manual gives you step-by-step instructions on how to install, configure and connect the LaCie 12big Rack Network storage subsystem to your host computer system, and how to use and maintain the system.

Who should use this guide

This user guide assumes that you have a working knowledge of storage appliance products. If you do not have these skills, or are not confident with the instructions in this guide, do not proceed with the installation.

The personnel referred to within this document are defined as follows:

- ◆ Service Person: A person having appropriate technical training and experience necessary to be aware of hazards to which that person may be exposed in performing a task and of measures to minimize the risks to that person or other persons.
 - ◆ User/Operator: Any person other than a Service Person.
-

Safety Guidelines

Safe Handling

CAUTION: If this equipment is used in a manner not specified by the manufacturer, the protection provided by the equipment may be impaired.

- ◆ All plug-in modules and blanking plates are part of the fire enclosure and must only be removed when a replacement can be immediately added. The system must not be run without all units in place. In order to comply with applicable safety, emission and thermal requirements no covers should be removed and all bays must be fitted with plug-in modules.

Permanently unplug the unit if you think that it has become damaged in any way and before you move it.

CAUTION: A fully assembled LaCie 12big Rack Network enclosure can weigh up to 30kg (66lb), 22kg (48.4lb) without drives installed. Do not try to lift it by yourself.

Do not lift the enclosure by the handles on the power supplies, as they are not designed to support that weight.

CAUTION: The removal of the enclosure top cover or the power supply mounting cage must only be performed by a service person. Potential hazards include: rotating fans and hot surfaces.

The enclosure top cover must be secured when the enclosure is in normal use, by rotating the lock 90° to the “locked” position (this is to prevent users/operators from accessing service areas).

Safety

- ◆ The LaCie 12big Rack Network unit must only be operated from a power supply input voltage range of 100 - 240 VAC, 50 - 60 Hz.
- ◆ The plug on the power supply cord is used as the main disconnect device. Ensure that the socket outlets are located near the equipment and are easily accessible.
- ◆ This equipment is intended to operate with two working Power Supply Units (PSUs) housed in a Power Supply Mounting Cage. Before removal/replacement of a PSU disconnect all supply power for complete isolation.
- ◆ A faulty PSU must be replaced with a fully operational PSU within 24 hours. Please refer to section 6.3. [Environment](#).
- ◆ A safe electrical earth connection must be provided to the power cord. Check the grounding of the enclosure before applying power.

CAUTION: Bifurcated power cords MUST NOT be used with the LaCie 12big Rack Network enclosure, this system does not support their use.

- ◆ Provide a suitable power source with electrical overload protection to meet the requirements laid down in the technical specification.
- ◆ Hot surfaces (heatsinks) are exposed when the enclosure top cover is removed. Disconnect power and allow to cool before removal/replacement of the SAS Expander PCB.

CAUTION: Do not remove covers from the PSU. Danger of electric shock inside. Return the PSU to your supplier for repair.

BBU Battery Safety (RAID option)

Please refer to section 5.9. [Replacing the Battery Backup Unit](#).

CAUTION: There is a danger of explosion if the battery is replaced by an incorrect type.

Dispose of used batteries in accordance with the manufacturer’s instructions and National regulations.

Equipment Handling Precautions

CAUTION: Operation of the Enclosure with ANY drive carrier modules missing will disrupt the airflow and the drives will not receive sufficient cooling. It is ESSENTIAL that all apertures are filled before operating the unit. Dummy drive carrier modules must be fitted to unused drive bays.

CAUTION: The RJ45 sockets on the Motherboard/PCI cards are for Ethernet connection only and must not be connected to a telecommunications network.

CAUTION: Boot drives are fragile and must be handled with care during removal/replacement.

Rack System Safety Precautions

The following safety requirements must be considered when the unit is mounted in a rack.

- ◆ The rack construction must be capable of supporting the total weight of the installed enclosure(s) and the design should incorporate stabilizing features suitable to prevent the rack from tipping or being pushed over during installation or in normal use.
- ◆ When loading a rack with the units, fill the rack from the bottom up and empty from the top down.
- ◆ Always remove all modules and drives, to minimize weight, before loading the chassis into a rack.

CAUTION: To avoid danger of the rack toppling over, under no circumstances should more than one enclosure be drawn out of the cabinet at any one time.

- ◆ The system must be operated with low pressure rear exhaust installation. (Back pressure created by rack doors and obstacles not to exceed 5 pascals [0.5mm water gauge]).
 - ◆ The rack design should take into consideration the maximum operating ambient temperature for the unit, which is 35°C.
 - ◆ The rack should have a safe electrical distribution system. It must provide overcurrent protection for the unit and must not be overloaded by the total number of units installed in the rack. When addressing these concerns consideration of the electrical power consumption rating shown on the nameplate.
 - ◆ The electrical distribution system must provide a reliable earth for each unit and the rack.
 - ◆ Each Power Supply Unit has an earth leakage current of 1.4mA. The design of the electrical distribution system must take into consideration the total earth leakage current from all the power supplies in all the units. The rack will require labelling with "HIGH LEAKAGE CURRENT. Earth connection essential before connecting supply".
 - ◆ The rack when configured with the units must meet the safety requirements of UL 60950-1 and IEC 60950-1.
-

1. System Overview

1.1. The LaCie 12big Rack Network System

The LaCie 12big Rack Network storage system is a 2U (rack space) disk drive enclosure, currently housing up to twelve low profile (1 inch high), 3.5 inch form factor drives as follows:

- ◆ 1.5/3.0Gb/s SATA (up to 7200 rpm)

Each individual disc drive is hot pluggable and field replaceable.

Fig. 01 shows a front view of an LaCie 12big Rack Network enclosure while *Fig. 02* depicts a rear view with the lid removed, showing those areas accessible to service personnel only.



Fig. 01 - The LaCie 12big Rack Network System - Front View

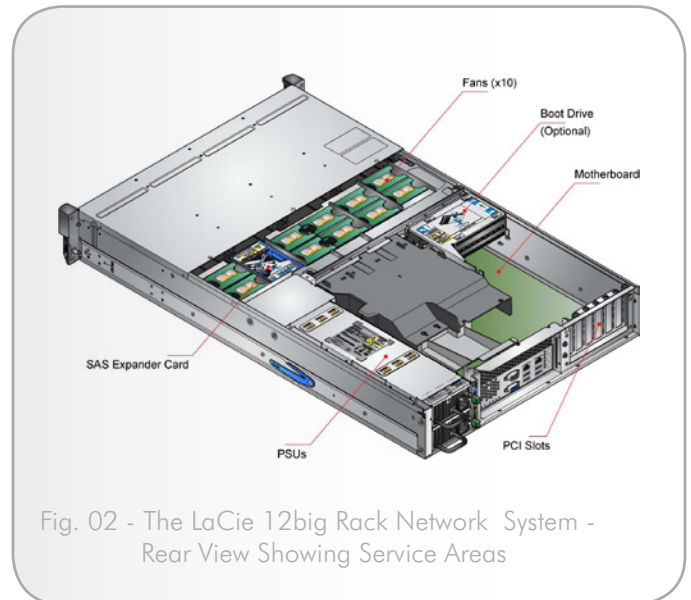


Fig. 02 - The LaCie 12big Rack Network System - Rear View Showing Service Areas

1.2. The Enclosure Core Product

The LaCie 12big Rack Network design concept is based on an enclosure subsystem together with a set of plug-in modules (as supplied) comprises:

- ◆ An Enclosure Chassis comprising:
 - A Backplane PCB,
 - An Enclosure Management PCB,
 - An SAS Expander PCB, to branch from 4 to 12 SAS ports, supporting SATA tunnelling protocol,
 - An integral Operator's (Ops) Panel,
 - An integral Rear Panel, incorporating an Enclosure ID LED and an NMI push-button (See [Fig. 09](#)), and
 - A Power Supply Mounting Cage containing two 850W, 100-240V AC auto-ranging, plug-in Power Supply Units, (see [Fig. 07](#)),
- ◆ An ATX Server Subsystem, please refer to section [1.4. ATX Server Subsystem](#) for details.
- ◆ A Cooling Cage, containing 10 high speed single rotor axial Fans which are individually pluggable.
- ◆ Up to 12 Drive Carrier modules with 3.5" drives installed, (See [Fig. 09](#)). The minimum number of drives which should be installed is 4.

NOTE: Dummy Drive Carrier modules must be fitted in all unused drive bays.

The High Speed Serial architecture of the LaCie 12big Rack Network storage system provides one 4-channel SAS cable from the SAS Expander PCB to the Motherboard or to the rear mounted SAS Controller/s (if fitted).

Module and major component locations are shown in [Fig. 02](#).

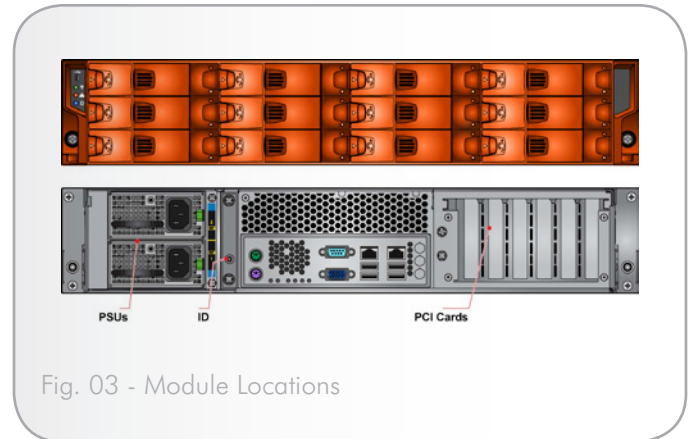


Fig. 03 - Module Locations

1.3. LaCie 12big Rack Network System Configurations

The following LaCie 12big Rack Network system configurations are offered:

Table 01 - System Configurations (Configuration A)

Configuration A	Basic System plus:
CPU	Quad Core Intel 5420
FDBMM	2 x 1GB
Boot Drives	2 x 80GB SATA (2.5")
Data Drives (3.5")	Up to 12 supported drives
RAID Option	RAID 1 for OS Boot internal drives
PCI Option (maximum 5)	LSI 8888 4i4e RAID controller for data drives
	2
	3
	4
	5



Fig. 04 - Enclosure Chassis

The Chassis (Fig. 04) consists of a sheet metal enclosure assembly containing an integrated Backplane PCB, Enclosure Management PCB and carrier runner system.

The chassis is fitted with 19 inch Rack mounting features which enables it to be fitted to standard 19 inch racks and uses 2 EIA units of rack space (i.e. 3.5" high).

- ◆ The Backplane PCB provides 12 direct dock SAS Serial ATA connectors to the drives and acts as the connectivity hub of the enclosure, connecting to the Enclosure Management PCB.
- ◆ The ten Cooling Fans are connected to the system via the Enclosure Management PCB.

There are 12 drive bays at the front of the enclosure. Each drive bay accommodates a plug-in Drive Carrier Module which houses Low Profile (1 inch) high 3.5 inch form factor drives.

NOTE: A Bay is defined as the space required to house a single 1.0" high 3.5 inch disk drive in its carrier module.

At the rear, the chassis assembly accommodates two Power Supply Units and ATX Server Subsystem.

The top cover on the enclosure provides access to the Cooling Fans and the ATX Server Subsystem.

IMPORTANT INFO: The cover should only be removed by service personnel as it provides access to a service area.

Upon replacement, the cover **MUST** be secured by turning the lock mechanism to the “locked” position with a screwdriver.

1.4. ATX Server Subsystem

The ATX Server Subsystem comprises

- ◆ An Intel®Star Lake S5000PSLSAS Motherboard, standard ATX form factor, with integral I/O panel.
 - ◆ Slots for up to 6 low profile 3/4 length PCI cards, installed in a vertical orientation. See section [1.3. LaCie 12big Rack Network System Configurations](#) for details of the cards used in the various configurations. (Blank PCI Plates are fitted in the empty slots)
 - ◆ RAID controller: LSI 8888 4i4e
-

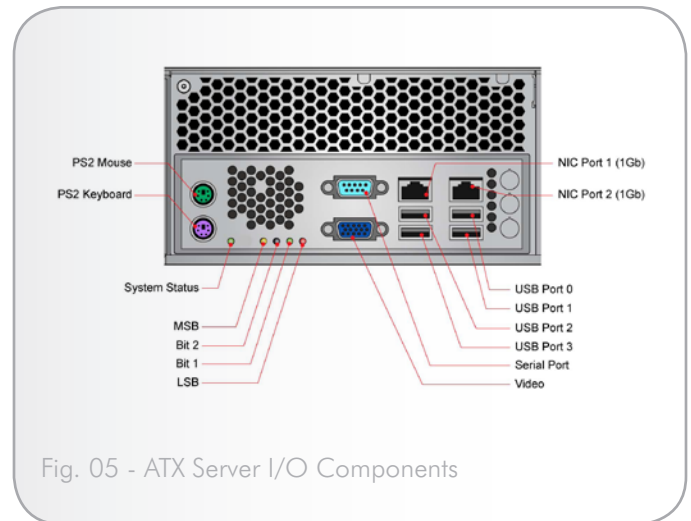


Fig. 05 - ATX Server I/O Components

1.4.1. ATX Server I/O Panel Connectors

The ATX Server I/O panel incorporates the following connectors:

- ◆ PS2 Mouse
- ◆ PS2 Keyboard
- ◆ Serial Port
- ◆ Video
- ◆ 2 x RJ45 - NIC Ports 1 & 2 (1Gb)
- ◆ 4 x USB - Ports 0, 1, 2, 3

The connectors are shown in [Fig. 05](#).

1.4.2. ATX Server LEDs

1.4.2.1. Status LEDs

The ATX Server I/O panel, shown in [Fig. 05](#), contains diagnostic LEDs to help you identify failed and failing components and to help you identify the server from among several servers. [Table 10](#) summarizes the LED states.

NIC LEDs

The Network Interface Controller (NIC) LEDs at the right and left of each NIC socket provide the information shown in [Table 11](#).

1.5. Operator's (Ops) Panel

The enclosure front panel incorporates an Operator's (Ops) Panel, shown in [Fig. 06](#).

IMPORTANT INFO: The Ops Panel is an integral part of the enclosure chassis assembly and is not field replaceable.

This assembly incorporates a USB socket, three LEDs and three push button switches, with the following functions:

Table 02 - OPS Functions

LEDs	Push-button Switches	USB Port
Power Active (Green)	Power On/Off	Intended for service use only.
Unit Fault (Amber)	System Reset	
Enclosure ID (Blue)	Enclosure ID LED Activation	

Please refer to section [3.3. Ops Panel LEDs and Switches](#) for a full description of the LED and switch functions.

1.6. Enclosure Rear Panel

The enclosure assembly includes an integral Rear Panel, incorporating an Enclosure ID LED (blue), shown in [Fig. 03](#).

Table 03 - Rear Panel LED Status

Enclosure ID LED	Blue (when activated)	Activated by push button on the Ops Panel, or by system software. Used to identify a server from among several servers
------------------	-----------------------	--

IMPORTANT INFO: The Rear Panel is an integral part of the enclosure chassis assembly and is not field replaceable.

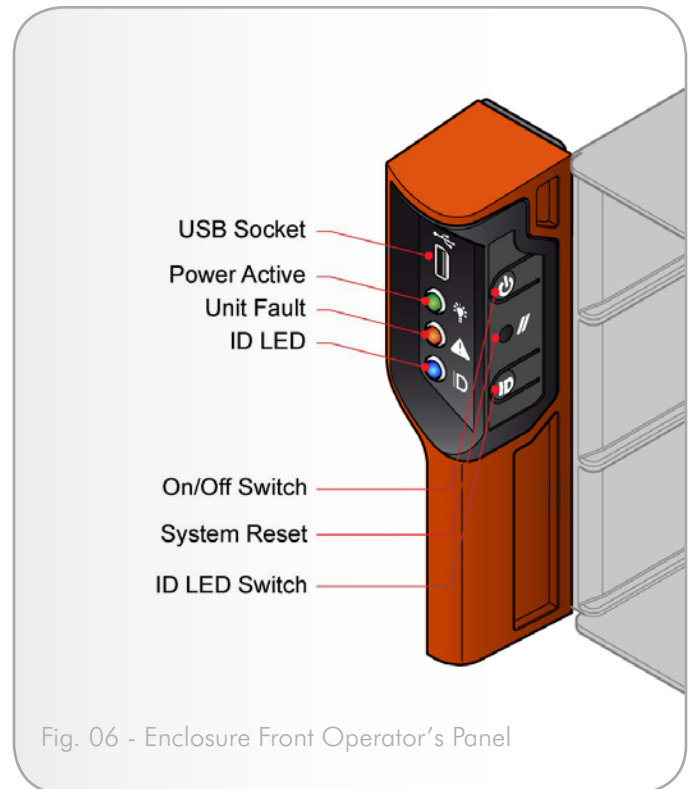


Fig. 06 - Enclosure Front Operator's Panel

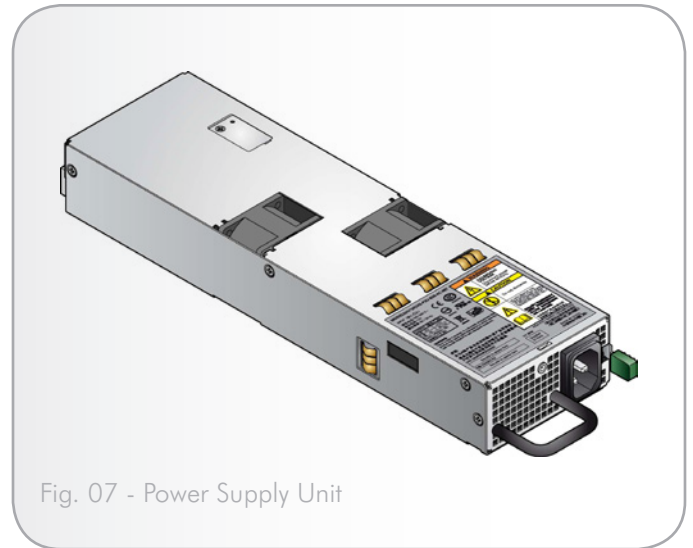
1.7. Power Supply Unit

AC-DC Power is provided by two dual-redundant power supply units with specific load capability, mechanical packaging and a power cage with output loom to suit this application.

A Power Supply Mounting Cage is fitted in the rear of the enclosure as part of the subsystem core product. The cage houses two individually hot pluggable 850W AC Power Supply Units (PSUs), each with its own IEC inlet connector and failure indicator.

PSU voltage operating ranges are nominally 100V - 240V AC, selected automatically. A typical PSU is shown in [Fig. 07](#).

Each PSU incorporate an Audible Alarm to indicate when a fault state is present and a bi-color (Green/Red) LED which indicates the PSU status.



1.7.1. Multiple Power Supply Units

The LaCie 12big Rack Network includes two PSUs fitted in the Power Supply Mounting Cage, providing dual power sources for the system so that if one PSU fails the other maintains the power supply and enclosure operation is not affected while you replace the faulty unit.

PSU replacement should only take a few minutes to perform but must be completed within 10 minutes from removal of the failed PSU.

1.7.2. Power Supply Output Loom

The Power Supply output loom provides the following outputs:

- ◆ P1 ATX Motherboard main power connectors (24 pin).
- ◆ P2 Processor power connector (8 pin)
- ◆ P3 12V power connector
- ◆ P4 Peripheral power connector (2 x 4 pin).
- ◆ P5 PSUI connector (5 pin)
- ◆ P5 SM bus connector (2 pin)

1.8. Cooling Fans

The Cooling Fans are high speed single rotor axial fans. Ten fans are housed in a Cooling Cage, located centrally within the enclosure, between the drive bays and the Motherboard, as shown in [Fig. 02](#). This ensures maximum airflow through the PSU and minimizes noise.

Airflow is front to rear with cooling air being drawn across the drives, through the fans and pressurizing the rear of the enclosure. The pressurized rear allows the PSU to draw the air that it requires, and perforations at the rear of the chassis allow cooling airflow over the Processor heatsinks, memory, motherboard and PCI cards.

The cooling system must be operated with low pressure rear exhaust installation [Back pressure created by rack doors and obstacles not to exceed 5 pascals (0.5mm Water gauge)]

The cooling system provides sufficient capacity to ensure that drive maximum temperatures are not exceeded at 35°C ambient with one fan failed at sea level.

The Cooling Cage contains ten individual high speed single rotor axial fans, individually connected to and interfacing with the Enclosure Management PCB. This interface provides power and speed control to the fans and returns tacho output from each fan

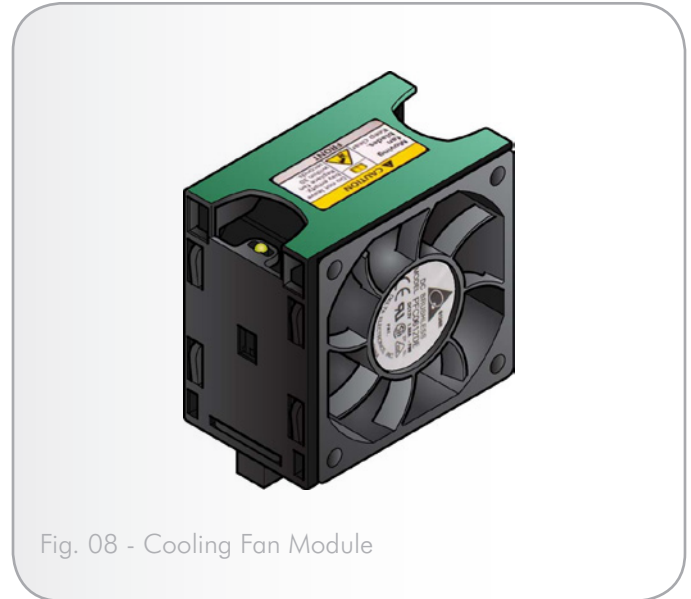


Fig. 08 - Cooling Fan Module

1.9. Drive Carrier Module

The Drive Carrier module comprises a hard disk mounted in a carrier. Each drive bay will house a single Low Profile 1.0 inch high, 3.5 inch form factor disk drive in its carrier. The carrier has mounting locations for SAS/SATA drives.

Each disk drive is enclosed in a sheet steel carrier which provides excellent thermal conduction, radio frequency and electro-magnetic induction protection and affords the drive maximum physical protection.

The front cap also supports an ergonomic handle which provides the following functions:

- ◆ Camming of carrier into and out of drive bays.
- ◆ Positive 'spring loading' of the drive/backplane connector.

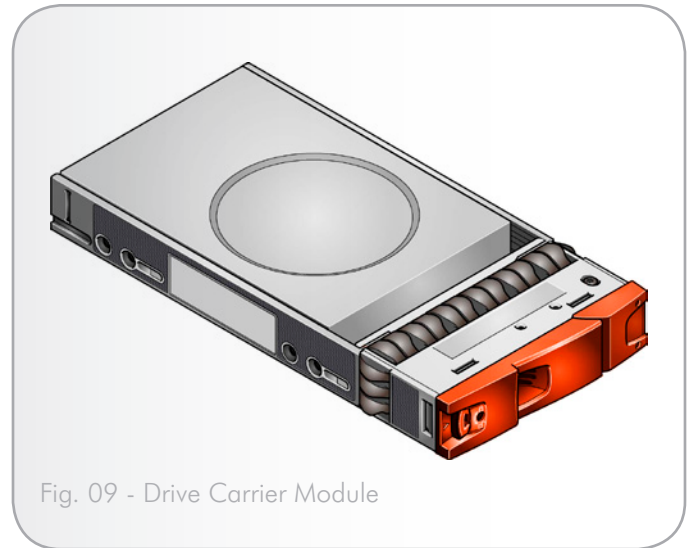


Fig. 09 - Drive Carrier Module

1.9.1. Drive Status Indicator

Disk drive status is monitored by a Green LED and an Amber LED mounted on the front of each Drive Carrier module, under ESI processor control, shown in [Fig. 10](#). Please refer to [4.2.4. Drive Carrier Module LEDs](#) for a description of the LED states.

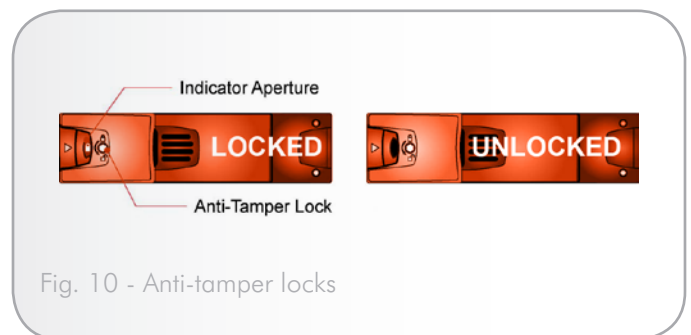


Fig. 10 - Anti-tamper locks

1.9.2. Anti-tamper Locks

Anti-tamper locks are fitted in the drive carrier handles ([Fig. 10](#)) and are accessed through the small cutout in the latch section of the handle. These are provided to disable the normal 'pinch' latch action of the carrier handle.

1.9.3. Dummy Drive Carrier Modules

Dummy Drive Carrier modules are provided for fitting in all unused drive bays. They are designed as integral drive module front caps with handles and must be fitted to all unused drive bays to maintain a balanced airflow.

1.9.4. Blanking Plates

Blanking Plates must be fitted in any vacant PSU bay or PCI card slots at the rear of the enclosure to maintain airflow and ensure correct operation.

CAUTION: Operation of the Enclosure with ANY modules missing will disrupt the airflow and the drives will not receive sufficient cooling.

1.10. Enclosure Management

The Enclosure Management PCB provides the required reporting functionality. No Operating System should be required to manage the following functions:

- ◆ Audible Alarm Control
- ◆ PSU Status monitoring
- ◆ Fan Speed reporting
- ◆ Fan Speed control
- ◆ Fan Fail monitoring (with Fault LED)
- ◆ Enclosure Temperature monitoring for CPU(s), FBDIMM(s), Motherboard, plenum
- ◆ Alarm on over temperature
- ◆ 3.5" HDD presence detection
- ◆ 3.5" HDD Fault LED control
- ◆ Front panel LED's and switches (including Enclosure Fault Indication)
- ◆ Intrusion detection
- ◆ Serial EEPROM to store system setup parameters
 - Serial number, machine type, number of drive bays etc.

StorView® management suite uses the industry standard SES communications protocol, which is the only supported communication method to the enclosure firmware. Other tools may cause unpredictable side effects and hence are not supported.

SES support is at ANSI SES 2.0 level and supports SES Pages 0, 1, 2, 5, 7, Ah and Eh. Download of the Enclosure firmware is supported via SES Page Eh. During firmware download all RAID data activity must be stopped.

2. Installation

2.1. Introduction

In this chapter, you are shown how to plan and install your LaCie 12big Rack Network Enclosure system into an industry standard 19 inch rack cabinet.

CAUTION: When connecting up the LaCie 12big Rack Network subsystem, use only the power cords supplied or cords which match the specification quoted in [7.7. AC Power Cords](#).

2.2. Planning Your Installation

Before you begin installation you should become familiar with the configuration requirements of your LaCie 12big Rack Network system. The correct locations of each of the plug-in modules are shown in [Fig. 11](#).

IMPORTANT INFO: Installation procedures should be performed by Service Personnel Only.

Table 04 - LaCie 12big Rack Network Configuration

Module	Location
Drive Bays	ALL drive bays must be fitted with a Drive Carrier module. No bays should be left completely empty. A minimum of 4 drives should be installed.
Power Supply Modules	Two Power Supply Units must be fitted. ◆ When two PSUs are installed in the Power Supply Module full power redundancy is provided while a faulty PSU is replaced.
Cooling Fans	Ten Fans, housed in a Cooling Cage, are located centrally within the enclosure, installed between the drive bays and the ATX Motherboard.
PCI Cards	The empty slots must be covered with blanking plates.

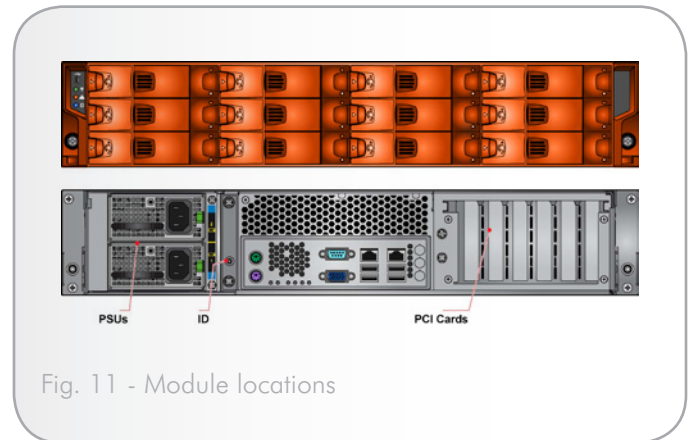


Fig. 11 - Module locations

2.3. Enclosure Installation Pre-Requisites

NOTE: LaCie 12big Rack Network enclosures are supplied and delivered fully populated with drive carrier modules preinstalled.

CAUTION: The LaCie 12big Rack Network Enclosure with all its component parts installed is too heavy for a single person to easily install into a Rack cabinet. The following procedures describe the installation of the LaCie 12big Rack Network enclosure and highlights any critical pre-requisite requirements and good handling practices which we encourage you to follow so as to ensure that a successful installation is achieved in the easiest manner.

CAUTION: Ensure that you have fitted and checked a suitable anti-static wrist or ankle strap and observe all conventional ESD precautions when handling LaCie 12big Rack Network modules and components. Avoid contact with Backplane, Motherboard and PCI card components and module connectors, etc.

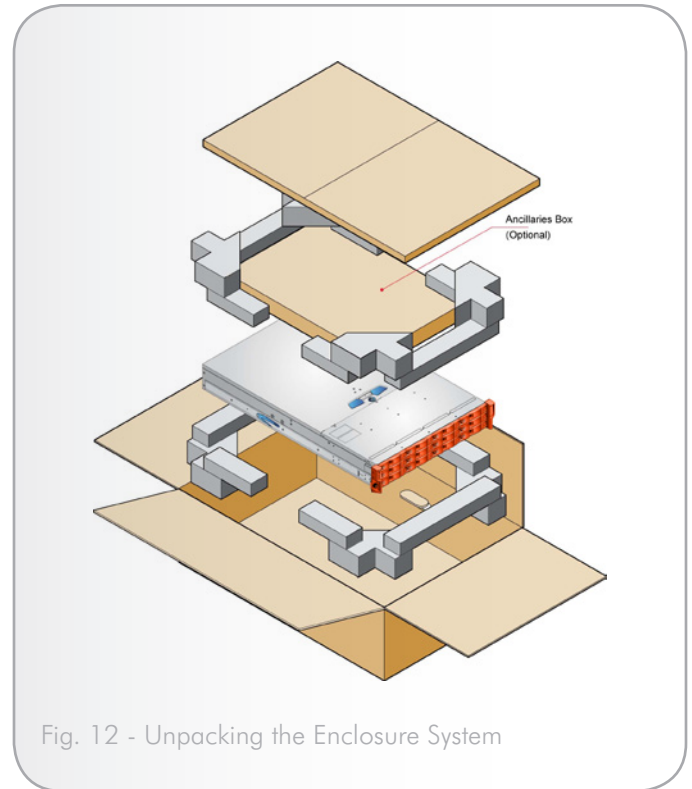


Fig. 12 - Unpacking the Enclosure System

2.3.1. Preparation of Site and Host Server

Before you begin, make sure that the site where you intend to set up and use your LaCie 12big Rack Network storage system has the following:

- ◆ Standard AC power from an independent source or a rack Power Distribution Unit with a UPS (universal power supply).

2.3.2. Unpacking the Enclosure System

The package contents and unpacking procedure are outlined in [Fig. 12](#).

2.3.3. Planning and Configuring Your Installation

Before you begin installation you should become familiar with the configuration requirements of your LaCie 12big Rack Network system. Please refer to [2.2. Planning Your Installation](#) for information on your overall system configurations.

When planning your system configuration, please remember that:

- ◆ All LaCie 12big Rack Network enclosure drive bays must be filled with a Drive Carrier module or a Dummy Drive Carrier module, no bays should be left completely empty.

2.3.4. Special Tools and Equipment

There are no special tools required but in order to complete the assembly of some configurations you may need the following:

- ◆ Flat blade screwdriver (not supplied)
- ◆ Torx driver (for drive module locks)

2.3.5. Rack Installation Pre-Requisites

The LaCie 12big Rack Network Enclosure is designed for installation into an industry standard 19 inch cabinet capable of holding the unit.

- ◆ Minimum depth 707mm (27.83 inches) from rack posts to maximum extremity of enclosure (excludes rear cabling).
- ◆ Weight: up to 30kg, dependent upon configuration, per enclosure.
- ◆ A minimum gap of 25mm (1 inch) clearance between the rack cover and front of drawer; and 50mm (2 inches) rear clearance between rear of drawer and rear of rack is recommended in order to maintain the correct air flow around the enclosure.
- ◆ The rack should present a maximum back pressure of 5 pascals (0.5mm water gauge).

CAUTION: Operation of the enclosure system with ANY modules missing will disrupt the airflow and the drives will not receive sufficient cooling. It is ESSENTIAL that all apertures are filled before operating the unit. Dummy Drive Carriers and/or Blanking Plates are available for this purpose.

2.4. Rack Mounting Rail Kit

A set of rack mounting rails is available for use in 19 inch rack cabinets. These rails have been designed and tested to handle the maximum enclosure weight and to ensure that multiple enclosures may be installed without loss of space within the rack. Use of other mounting hardware may cause some loss of rack space.

Please contact your supplier to ensure suitable mount rails are available for the rack you are using.

Important Please refer to section [Rack System Safety Precautions](#) before you begin the assembly procedure.

2.4.1. Mounting Rail Kit Installation

Please refer to the detail drawings supplied with the Rack Mounting Rail Kit for assembly details (Xyratex P/N 82864-01). This drawing is also shown in [8. Rack Kit Reference Drawing](#).

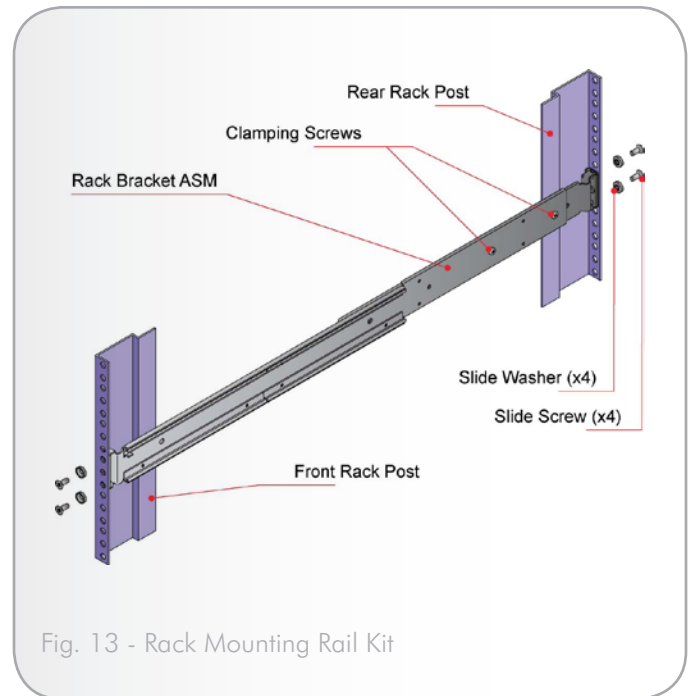


Fig. 13 - Rack Mounting Rail Kit

2.5. Chassis Installation

2.5.1. Parts Check List

- ◆ Chassis, complete with Backplane PCB, ATX Motherboard, Enclosure Management PCB, SAS Expander PCB, Ops Panel, Intel® RAID Controller (optional), Battery Backup Unit (optional), Blank Plates (covering empty PCI slots) and all plug-in modules installed.
- ◆ Rack Mounting Rail Kit

2.5.2. Procedure

1. Check for damage.
2. Lift chassis and align with front rails.
3. Carefully insert chassis slides into rack rails and push fully home.
4. Tighten rear screws.
5. Withdraw chassis until it reaches hard stops (approximately 400mm).
6. Tighten front screws.
7. Return chassis to fully home position and attach to rack using captive fasteners on front flanges.

IMPORTANT INFO: Chassis rails have features to restrict chassis withdrawal while allowing access to fans. If it becomes necessary to remove the chassis completely, pull the chassis out until it reaches its stops then rotate the latches shown in [Fig. 13](#) (right hand up, left hand down) before continuing to fully withdraw the chassis.

2.6. Module Installation

IMPORTANT INFO: LaCie 12big Rack Network enclosures are supplied and delivered populated with Backplane PCB, ATX Motherboard, Enclosure Management PCB, SAS Expander PCB, Ops Panel, Intel® RAID Controller (optional), Battery Backup Unit (optional) and all plug-in modules installed.

For information on removal/replacement of plug-in modules, please refer to [4. Troubleshooting & Problem Solving](#).

2.6.1. Dummy Drive Carrier Modules

Dummy Drive Carrier modules must be fitted in all unused drive bays to maintain a balanced airflow.

2.6.2. Blanking Plates

Blanking Plates must be fitted in any vacant PSU bay or PCI card slots at the rear of the enclosure to maintain airflow and ensure correct operation.

IMPORTANT INFO: Operation of the enclosure system with ANY modules missing will disrupt the airflow and the drives will not receive sufficient cooling.

2.7. Power Cord Connection

2.7.1. Parts Check List

- ◆ Power cords to requisite local standards

2.7.2. Procedure

1. Attach the power cords to the two Power Supply Units.

IMPORTANT INFO: To ensure redundancy the two power cords must be connected to separate and independent supplies.

2. The Power On LED on each PSU indicates whether AC mains power is present (flashing Green).

CAUTION: The power connections must always be disconnected prior to removal of the Power Supply Unit from the enclosure.

CAUTION: Bifurcated power cords MUST NOT be used with the LaCie 12big Rack Network enclosure, this system does not support their use.

2.8. Grounding Checks

The product must only be connected to a power source that has a safety electrical earth connection.

CAUTION: If more than one product is fitted in a rack, the earth connection to the rack is even more important, because the rack will then have a high "EARTH LEAKAGE CURRENT" ("TOUCH CURRENT").

The earth connection to the rack must be checked before switching on, by an electrical engineer who is qualified to the appropriate local and National standards to perform the check.

2.9. Data Security

- ◆ Power down your host computer and all attached peripheral devices before beginning installation.
 - ◆ Each enclosure contains up to 12 removable disk drive modules. Disk units are fragile. Handle them with care, and keep them away from strong magnetic fields.
 - ◆ All the supplied plug-in modules and blanking plates must be in place for the air to flow correctly around the enclosure and also to complete the internal circuitry.
 - ◆ If the subsystem is used with modules or blanking plates missing for more than a few minutes, the enclosure can overheat, causing power failure and data loss. Such use may also invalidate the warranty.
 - ◆ If you remove a drive module, replace it immediately. If it is faulty, replace it with a drive module of the same type and capacity.
 - ◆ Ensure that all disk drives are removed from the enclosure before attempting to manhandle or move the rack installation.
 - ◆ Do not abandon your backup routines. No system is completely foolproof.
-

CAUTION: Prior to removing the PSU from the Power Supply Mounting Cage in the enclosure: Please disconnect the power from the power supply, by either the mains switch (where present) or by physically removing the power source, to ensure your system has warning of an imminent power shutdown.

3. Operation

3.1. Before You Begin

Before powering up the enclosure please ensure that all the modules are firmly seated in their correct bays.

3.2. Power On

CAUTION: Do not operate the subsystem until the ambient temperature is within the specified operating range. If the drives have been recently installed ensure they have had time to acclimatize before operating them.

NOTE: Please refer to [Fig. 14](#) for details of the Ops Panel LEDs and related fault conditions.

Follow the procedure below to Power On the enclosure.

1. Apply AC Mains power to the enclosure.
2. The Power Active LED on the Ops Panel should be lit (Green) when the enclosure power button is pressed (and the disk drive motors should start).

IMPORTANT INFO: If mains power is lost for any reason, on restoration of power the enclosure will re-start automatically.

3.2.1. Power Supply Unit LEDs

The PSU incorporates a bi-color Red/Green LED.

- ◆ When the PSU is connected to a mains supply the Green LED will flash.
- ◆ When the PSU is switched on the Green LED will be continuously illuminated.
- ◆ If a fault occurs the Red LED will be continuously illuminated.
- ◆ The Red LED will flash to signify Over Current, Under Voltage or Over Voltage Protection conditions.

Power Supply LEDs and switches are shown in [Fig. 14](#).

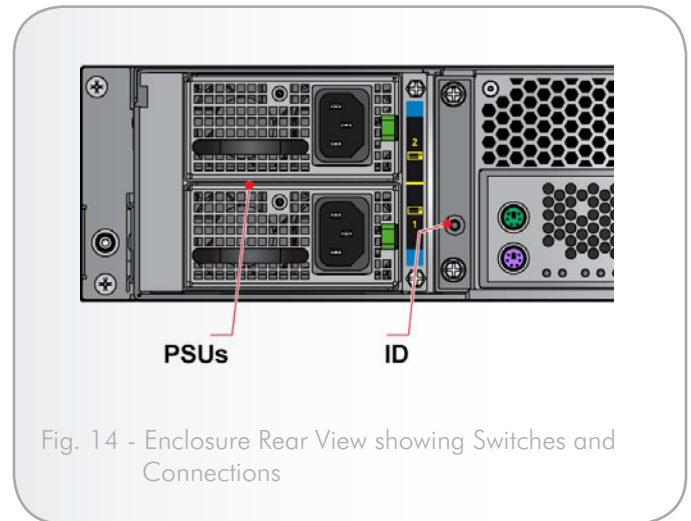


Fig. 14 - Enclosure Rear View showing Switches and Connections

3.3. Ops Panel LEDs and Switches

The Ops Panel LEDs (Fig. 15) fault and status conditions are defined in Table 05 while the functions of the push-button switches are defined in Table 06.

Please refer to 4. *Troubleshooting & Problem Solving* for details of any fault indication.

Table 05 - Ops Panel LEDs

LEDs	Status
Power Active	Constant Green: good or positive indication.
Unit Fault	Constant Amber: fault present
Enclosure ID	Blue: only when activated

Table 06 - Ops Panel Switches

Push-button Switches	Definition
On/Off	<p>Function of this button is dependent on the enclosure status</p> <ul style="list-style-type: none"> ◆ Enclosure connected to power source but not operating: Press button to activate and commence boot process ◆ Enclosure operating: Depress button for <4 seconds to shut down the enclosure
System Reset	<p>Resets the enclosure hardware and firmware.</p> <p>Note: This button is recessed and is activated with a ball-point pen or similar implement.</p>
Enclosure ID LED	Each press of this button causes the state of the blue ID LEDs on the Ops Panel and rear panel to change.

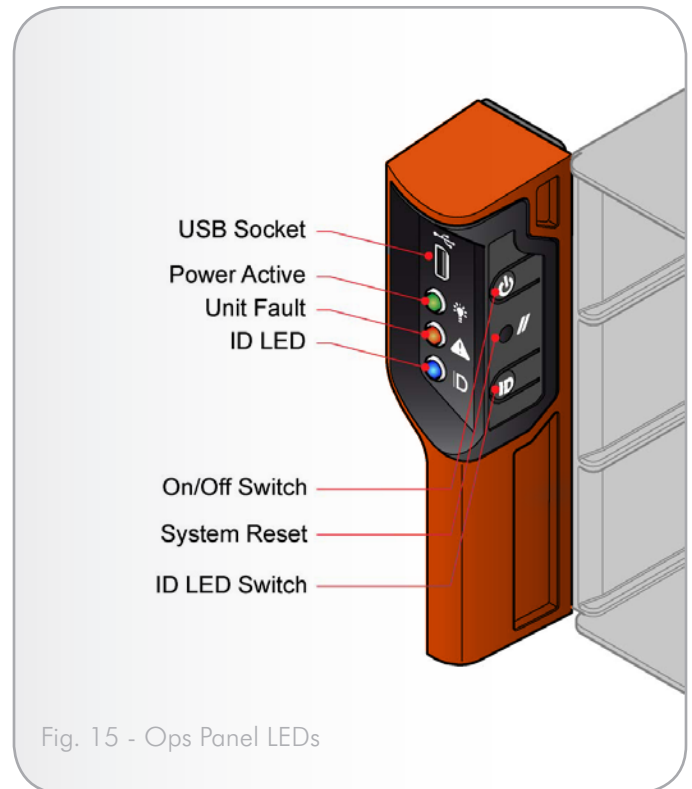


Fig. 15 - Ops Panel LEDs

3.4. Starting the Drives

Unless otherwise selected during installation, all drives in the enclosure should automatically start their motors. If this has not occurred one of the following conditions may exist:

- ◆ There may be a power problem (an alarm and power fault indication would normally be active).
- ◆ If there is only one PSU present, the drive motors will spin up in a delayed sequence.

3.4.1. Disk Drive LEDs

Each Drive Carrier module incorporates two LEDs, Upper (Green) and Lower (Amber), shown in [Fig. 10](#).

- ◆ In normal operation the Green LED will be ON and will flicker as the drive operates.
- ◆ In normal operation the Amber LED state will be:
 - OFF if there is no drive present,
 - OFF as the drive operates, and
 - ON if there is a drive fault present.

3.4.2. Engaging the Drive Module Anti-tamper Locks

The anti-tamper locks are fitted in the drive carrier handles and are accessed through the small cutout in the latch section of the handle.

3.4.2.1. Activating the Locks

1. Carefully insert the lock key provided into the cutout in the handle.
2. Locate the key into its socket.
3. Rotate the key in a clockwise direction until the indicator is visible in the aperture beside the key.
4. Remove the key. De-activation is the reverse of this procedure, that is:
 - ◆ Rotate the key in an anti-clockwise direction until the indicator is no longer visible in the aperture beside the key.

NOTE: A drive carrier cannot be installed if its anti-tamper lock is activated outside the enclosure.

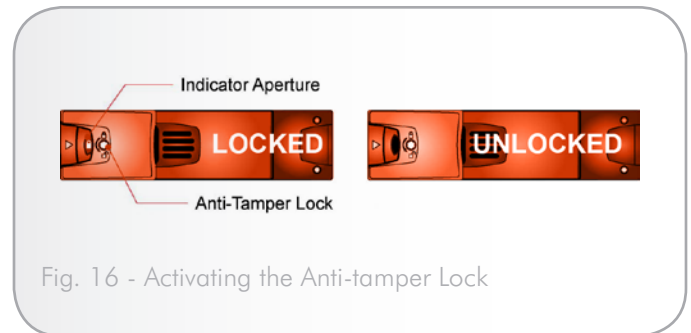


Fig. 16 - Activating the Anti-tamper Lock

3.5. Power Down

To power the enclosure down, either

- ◆ Switch off the Power Supply Unit(s) installed in the enclosure by pressing the Power push-button on the Ops Panel assembly (shown in [Fig. 17](#)) for approximately 3 seconds.

or

- ◆ Remove AC mains at the power source

IMPORTANT INFO: Disconnect both power cords for complete isolation.

4. Troubleshooting & Problem Solving

4.1. Overview

The LaCie 12big Rack Network Enclosure includes an Enclosure Services Processor and associated monitoring and control logic to enable it to diagnose problems within the Enclosure Management Card, Ops Panel, CPU(s) and DIMM(s).

The sensors for power and cooling conditions are housed within the Power Supply and Cooling Fans. There is independent monitoring for each unit.

4.1.1. Initial Start-up Problems

4.1.1.1. Faulty Cords

First check that you have wired up the subsystem correctly. Then, if:

- ◆ cords are missing or damaged
- ◆ plugs are incorrect
- ◆ cords are too short

Call your supplier for a replacement.

4.1.1.2. Alarm Sounds On Power Up

Please refer to [4.3. Audible Alarm](#).

4.1.1.3. Computer Doesn't Recognize the LaCie 12big Rack Network Subsystem

1. Check that the interface cables from the LaCie 12big Rack Network enclosure to the host computer are fitted correctly.
 2. Check that the LEDs on all installed drive carrier modules are illuminated (Amber). Note that the drive LEDs will not be lit during drive spinup.
 3. Check that Drive Carrier Modules have been correctly installed.
-

4.2. LED States

Green LEDs are always used for good or positive indication, flashing Green/Amber if non-critical conditions exist. Red or Amber LEDs indicate there is a critical fault present within the module; with the exception of the Drive Carrier Module LED which is lit Amber under Normal conditions (see section 4.6. *Drive Carrier Module Faults*).

4.2.1. Power Supply Unit LEDs

Under Normal conditions the bi-color Power On LEDs will be illuminated constant GREEN. When a fault occurs the Power On LEDs will be illuminated constant RED.

Table 07 - PSU LED States

Status	Condition	Definition
Green (Flashing)	+3V3SB – ON; +12VOUT – OFF; AC PRESENT	Mains supply connection to PSU present
Green	+3V3SB – ON, +12VOUT – ON	PSU power switched ON
Red (Flashing)	+12V_OCP, +12V_UVP, +12VOVP	Over Current/Under Voltage/Over Voltage Protection
Red	(PSU) FAN_FAULT, OTP, 3V3_OCP/UVP	Fault present

4.2.2. Ops Panel LEDs

The Ops Panel (*Fig. 17*) displays the aggregated status of all the modules. The Ops Panel LEDs are defined in *Table 08*.

NOTE: The Ops Panel is supplied as an integral part of the enclosure core product and is not user replaceable.

Table 08 - Ops Panel LED States

Status	Condition	Definition
Power Active	Constant Green: good or positive indication.	
Unit Fault	OFF	Constant Amber: fault present
Enclosure ID	Blue: only when activated	

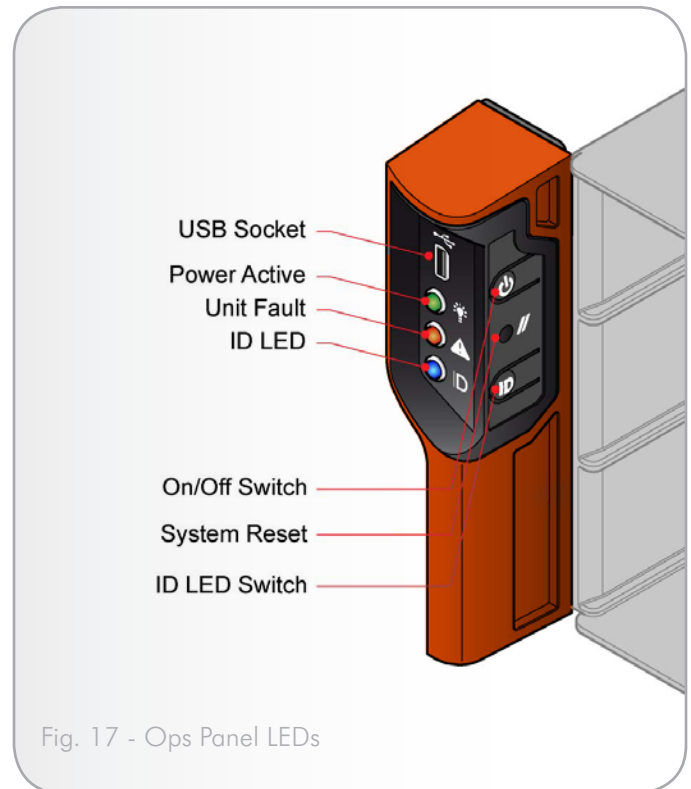


Fig. 17 - Ops Panel LEDs

4.2.3. Cooling Fan LEDs

An Amber LED incorporated in each fan module monitors its status, constant On indicates a Fault condition while a flashing light indicates that the fan ident is On. The LED is Off during Normal operation.

4.2.4. Drive Carrier Module LEDs

Disk drive status is monitored by a GREEN LED and an AMBER LED mounted on the front of each Drive Carrier module, shown in [Fig. 18](#). The LED conditions are defined in section [4.6. Drive Carrier Module Faults](#):

4.2.5. Rear Panel LED

Table 09 - Rear Panel LED Status

Enclosure ID LED	Blue (when activated)	Activated by push button on the Ops Panel, or by system software. Used to identify a server from among several servers
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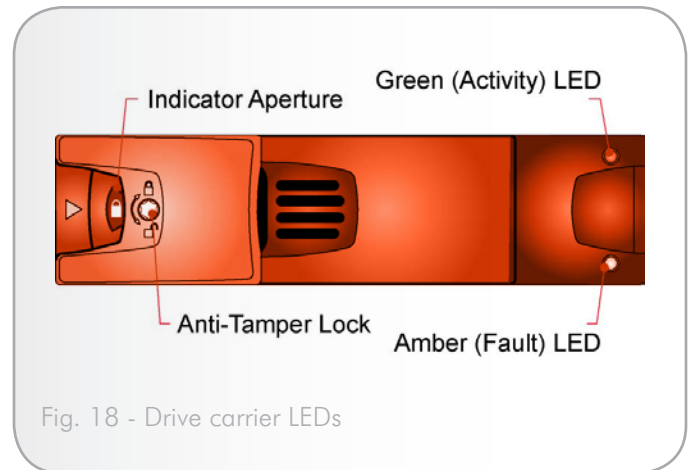


Fig. 18 - Drive carrier LEDs

4.2.6. ATX Server LEDs

4.2.6.1. Status LEDs

The ATX Motherboard I/O panel contains a number of diagnostic LEDs, summarized in [Table 10](#):

Table 10 - ATX Server Status LEDs

LED	Color	Function
System Status LED	Green	System OK
	Off	AC Power Off
	Alternating Green/Amber	System Not Ready
	Amber	Critical Fault
	Green Blink	System Degraded
	Amber Blink	Non-fatal alarm, system likely to fail
4 x Power-On Self Test (POST) LEDs	Off	System Running normally The POST LEDs toggle between red, green, amber and Off at boot up.
	*Amber	*(Lit amber only if a failure occurs).

4.2.6.2. NIC LEDs

The Network Interface Controller (NIC) LEDs are defined in [Table 11](#). Please refer to your ATX Server documentation for full details of the LED states.

Table 11 - NIC LEDs

LED	LED State	Description
Left	Off	No network connection is in place
	Solid green	Active network connection is in place
	Blinking green	Transmit / receive activity is occurring
Right	Off	10 Mbps connection (if left LED is on or blinking)
	Solid green	100 Mbps connection
	Solid amber	1000 Mbps connect

4.3. Audible Alarm

The PSUs include Audible Alarms which indicates when a fault state is present. A Voltage Out Of Range condition will activate the audible alarm:

The audible alarm can be muted by pressing the Enclosure ID button on the Ops Panel.

4.4. Alarm Interpretation

Table 12 summarizes the various states of the LEDs and Audible Alarm to help you understand what an enclosure is trying to tell you by the pattern of lights and beeps. It takes each light/beep in turn and shows linked items, so data is duplicated in some places to make ease of search better.

NOTE: There will be no beep if the enclosure is muted

Table 12 - Light and Buzzer Interpretation

LED/Buzzer	State	Related	Meaning	Action
Ops Panel Fault Light	Off	--	No warnings or worse	None - All OK
	Slow blink (0.5 seconds on, 3.5 seconds off)	Slow beep (half second beep every 8 seconds). No Fan/drive lights lit constant. No beep if muted.	Warning state – usually approaching temperature threshold	Check ambient temperature and increase if too cold or decrease if too hot. If this does not work check for fan failure that has a broken light too.
		Slow beep. Fan light constant. No beep if muted.	Fan broken or out of tolerance	Replace lit fan.
		Slow beep. Drive light constant. No beep if muted.	Drive fault	Replace drive
	Fast Blink (alternating every half second)	Faster beep (1.5 seconds beep, 0.5 second silence). No fan lights constant. No beep if muted.	Critical state – usually temperature near edge of operating realm	Check ambient temperature and increase if too cold or decrease if too hot immediately. If this does not work check for fan failure that has a broken light too.
		Faster beep, More than one fan light on or a single PSU fan light on. No beep if muted.	Fans broken or out of tolerance	Replace Fans immediately

LED/Buzzer	State	Related	Meaning	Action
	Constant On	Constant – no fan lights lit constant	Failure State – temperature in range where damage could occur	Check ambient temperature and increase if too cold or decrease if too hot immediately. If this does not work check for fan failure that has a broken light too.
		Constant – multiple fan lights lit constant	Fans broken or out of tolerance	Replace Fans immediately. Decrease ambient temperature
Fan Light	Constant On	Varying levels of beep and chassis fault light setting. No beep if muted.	Fan broken or out of tolerance	Replace Fans immediately.
	Flashing		Fan Ident On	--
Drive Light (amber)	Constant On	Varying levels of beep and chassis fault – usually slow beep and slow flash. No beep if muted.	Drive faulty	Replace drive
	Flashing		Drive Ident On	--
Ops Panel Ident LED	Flashing		Ops Panel Ident On	--
Buzzer	Off	Ops Panel Fault LED Off	No issues	Smile
	Off	Ops Panel Fault LED Flashing or Constant	Muted.	See Ops Panel LED settings above for interpretation of lights and remedy.
	Intermittent short beep (0.5 second beep every 32 seconds)	Various Ops Panel Fault light flash states	Fault has occurred and system is muted but in remind mode	Check fault status using Ops Panel fault LED settings and remedy.
	Slow beep (half second beep every 8 seconds).	Ops Panel Fault LED slow blink (0.5 seconds On, 3.5 seconds Off).	Warning Mode	See Ops Panel fault LED settings above
	Faster beep (1.5 seconds beep, 0.5 second silence).	Ops Panel Fault LED fast blink (alternating every half second)	Critical Mode	See chassis fault LED settings above
	Constant beep	Ops Panel Fault LED constant On	Failure Mode	See Ops Panel fault LED settings above

4.5. Troubleshooting

The following sections describe common problems, with possible solutions, which can occur with your LaCie 12big Rack Network system.

For details on how to remove and replace a module see [5.3. Replacing a Module](#).

4.5.1. System Faults

Table 13 - System faults

Symptom	Cause	Action
Audible alarm sound	Internal fault detected (e.g. failure of an internal communications path)	Check for other AMBER LED indications on the Power Supply Units. If there is a PSU error present there may be a communications problem with that Power Supply Unit. Remove and then re-fit the PSU, if the problem persists then change the PSU.

4.5.2. Power Supply Unit Faults

Table 14 - Power Supply Unit Faults

Symptom	Cause	Action
Ops Panel UNIT FAULT LED amber	Any power fault.	Check AC mains connections to Power Supply Unit is live.
Audible alarm sounding.	A thermal condition which could cause PSU overheating.	Disconnect the PSU from mains power and remove the PSU from the PS cage. Re-install: if problem persists, replace PSU.
		Reduce the ambient temperature.

4.5.3. Cooling Fan Faults

Table 15 - Cooling Fan Faults

Symptom	Cause	Action
Front Panel fault LED amber.	Any power fault.	Check DC power to cooling fans is correct and that the fan LED is not illuminated.
Audible alarm sounding.	A fan failure.	Disconnect the PSU from mains power and remove the faulty fan from the system. Reinstall. If problem persists, replace PSU.
Fan LED is illuminated.		Reduce the ambient temperature.

4.5.4. Thermal Monitoring and Control

The LaCie 12big Rack Network enclosure uses extensive thermal monitoring and takes a number of actions to ensure component temperatures are kept low and also to minimize acoustic noise. Air flow is from front to rear of the enclosure.

Table 16 - Thermal Monitoring and Control

Symptom	Cause	Action
<p>If the ambient air is cool (below 25 °C) and the fans are observed to increase in speed then some restriction on airflow may be causing additional internal temperature rise.</p> <p>Note: This is not a fault condition.</p>	<p>The first stage in the thermal control process is for the fans to automatically increase in speed when a thermal threshold is reached. This may be caused by higher ambient temperatures in the local environment and may be perfectly normal.</p> <p>Note: This threshold changes according to the number of drives and power supplies fitted.</p>	<ol style="list-style-type: none"> 1. Check the installation for any airflow restrictions at either the front or rear of the enclosure. A minimum gap of 25mm at the front and 50mm at the rear is recommended. 2. Check for restrictions due to dust build-up; clean as appropriate. 3. Check for excessive re-circulation of heated air from rear to the front, use in a fully enclosed rack installation is not recommended. 4. Check that all Blank modules are in place. 5. Reduce the ambient temperature.

4.5.5. Thermal Alarm

Table 17 - Thermal Alarm

Symptom	Cause	Action
<ol style="list-style-type: none"> 1. Ops Panel UNIT FAULT LED amber. 2. An amber LED on one or more Power Supply Units. 	<p>If the internal temperature measured in the airflow through the enclosure exceeds a pre-set threshold a thermal alarm will sound.</p>	<ol style="list-style-type: none"> 1. Check local ambient environment temperature is below the upper 35°C specification. 2. Check the installation for any airflow restrictions at either the front or rear of the enclosure. A minimum gap of 25mm at the front and 50mm at the rear is recommended. 3. Check for restrictions due to dust build-up, clean as appropriate. 4. Check for excessive re-circulation of heated air from rear to the front, use in a fully enclosed rack installation is not recommended. 5. If possible shutdown the enclosure and investigate the problem before continuing.

4.6. Drive Carrier Module Faults

Each Drive Carrier module incorporates two LEDs, Upper (Green) and Lower (Amber), shown in [Fig. 10](#).

- ◆ In normal operation the Green LED will be ON and will flicker as the drive operates
- ◆ In normal operation the Amber LED state will be:
 - OFF if there is no drive present,
 - OFF as the drive operates, and
 - ON if there is a drive fault present.

IMPORTANT INFO: Dummy Drive Carrier modules must be fitted to all unused drive bays to maintain a balanced air flow.

4.7. Dealing with Hardware Faults

Ensure that you have obtained a replacement module of the same type before removing any faulty module.

CAUTION: If the LaCie 12big Rack Network subsystem is powered up and you remove any module, replace it immediately. If the subsystem is used with modules or module blanks missing for more than a few minutes, the enclosure can overheat, causing power failure and data loss. Such use will invalidate the warranty.

- ◆ Replace a faulty drive with a drive of the same type and equal or greater capacity.
- ◆ All drive bays must be fitted with a Drive Carrier module in order to maintain a balanced air flow.
- ◆ All the supplied plug-in power supply units, electronics modules and blank modules must be in place for the air to flow correctly around the cabinet.

CAUTION: Observe all conventional ESD precautions when handling LaCie 12big Rack Network modules and components. Avoid contact with Backplane components and module connectors, etc.

IMPORTANT INFO: The top cover of the enclosure covers a service area which should be accessed by service personnel only. When the cover is replaced it **MUST** be secured by turning the lock mechanism to the “locked” position.

4.8. Continuous Operation During Replacement

Depending on how the enclosure system is set up, if a disk unit fails, it can normally be replaced without interrupting the use of the system.

If an enclosure contains two Power Supply Units, either of them can maintain power to the subsystem while the other is replaced.

5. Module Replacement

5.1. Overview

The LaCie 12big Rack Network Enclosure includes an Enclosure Services Processor and associated monitoring and control logic to enable it to diagnose problems within the enclosure's power, cooling and drive systems.

The sensors for power and cooling conditions are housed within the Enclosure Management Card, Ops Panel, CPU(s) and DIMM(s). There is independent monitoring for each unit.

5.2. ESD Precautions

CAUTION: It is recommended that you fit and check a suitable anti-static wrist or ankle strap and observe all conventional ESD precautions when handling LaCie 12big Rack Network plug-in modules and components. Avoid contact with backplane components and module connectors, etc.

5.3. Replacing a Module

CAUTION: Whenever replacing a module NEVER leave an EMPTY bay in the rear of the enclosure, obtain a replacement before removing the problem part.

CAUTION: Upon module replacement, the enclosure top cover MUST be secured by turning the lock mechanism to the "locked" position with a screwdriver.

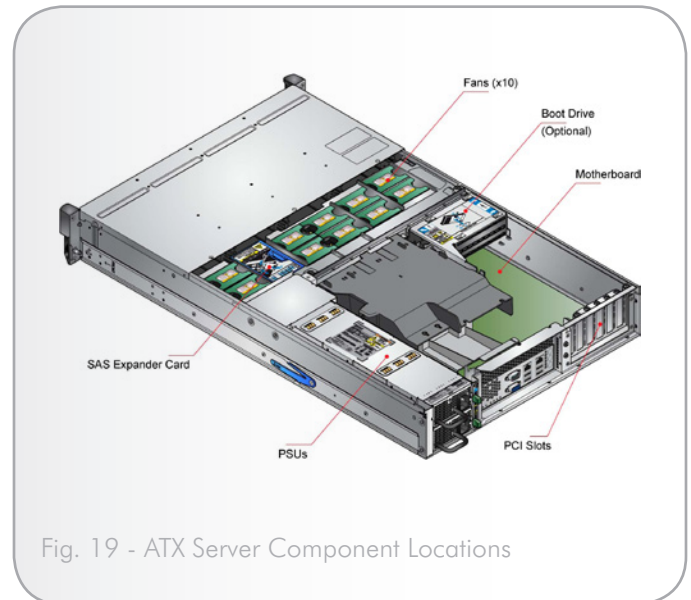


Fig. 19 - ATX Server Component Locations

5.3.1. Power Supply Units

The LaCie 12big Rack Network enclosure system incorporates two PSUs, housed in a mounting cage. PSU modules are individually installed.

IMPORTANT: A faulty PSU must be replaced by a fully operational PSU within 24 hours.

CAUTION: Do not remove covers from the Power Supply Unit (PSU). Danger of electric shock inside. Return the PSU to your supplier for repair.

5.3.1.1. Removing a Power Supply Unit

CAUTION: The removal of the enclosure top cover or a Power Supply Unit must only be performed by a service person.

Potential hazards include:

- ◆ Rotating fans
 - ◆ Hot surfaces
-

IMPORTANT INFO: Prior to removing the PSU from the mounting cage in the enclosure: Please disconnect the power from the power supply, by either the mains switch (where present) or by physically removing the power source, to ensure your system has warning of an imminent power shutdown.

1. Ensure that you identify the faulty PSU correctly.
 2. Switch off and disconnect the power cord.
 3. Squeeze the locking tab to the left ([Fig. 20](#)).
 4. Grip the handle and withdraw the PSU from the mounting cage ([Fig. 21](#)).
-

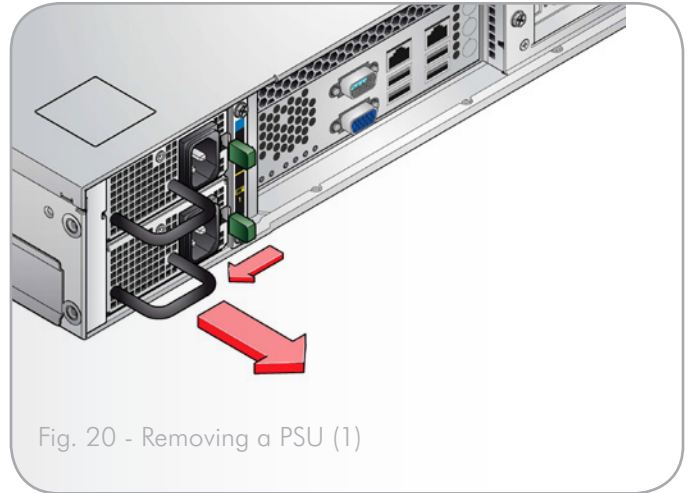


Fig. 20 - Removing a PSU (1)

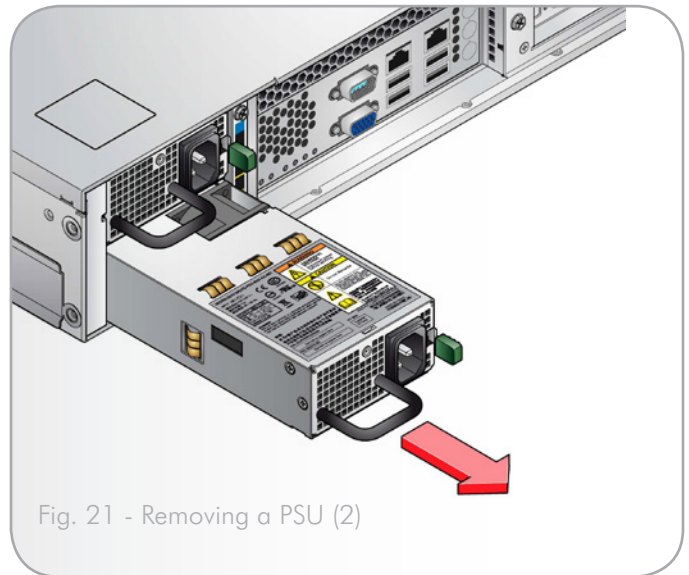


Fig. 21 - Removing a PSU (2)

5.3.1.2. Installing a Power Supply Unit

CAUTION: This procedure should be performed by Service Personnel only.

Two PSUs can be installed in the mounting cage at the rear of the enclosure, see [Fig. 03](#).

Parts Check List

- ◆ 2 x 850 W AC Power Supply Units

IMPORTANT INFO: Two PSUs must be fitted. Operation of the Enclosure with ANY modules missing will disrupt the airflow and the drives will not receive sufficient cooling. It is ESSENTIAL that all apertures are filled before operating the unit.

CAUTION: Do not remove covers from the PSUs. Danger of electric shock inside. Return the PSU to your supplier for repair.

1. Check for damage, especially to the rear connector on the supply.

CAUTION: Handle the PSU carefully and avoid damaging the connector pins. Do not install the PSU if any pins appear to be bent.

2. Slide the PSU into the mounting cage ([Fig. 23](#)). A click should be heard as the securing spring engages.
3. You are now ready to connect the power cords to the power sources and switch the power source ON. Please refer to section [2.7. Power Cord Connection](#).

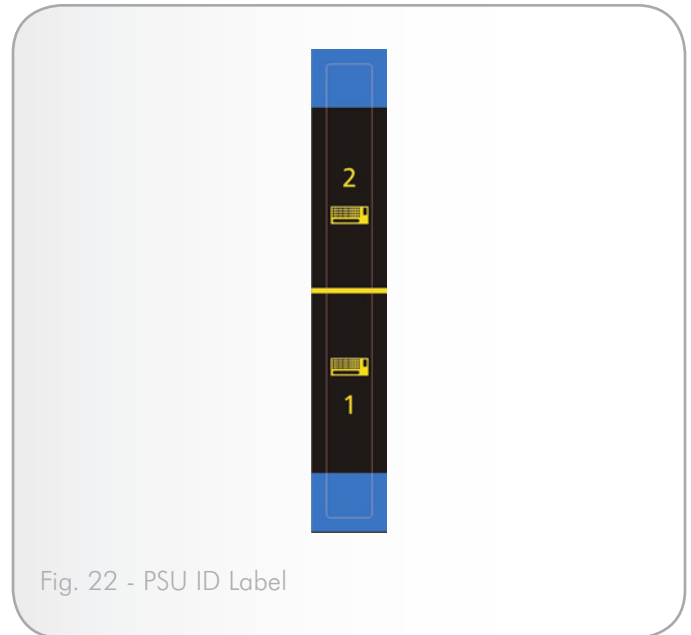


Fig. 22 - PSU ID Label

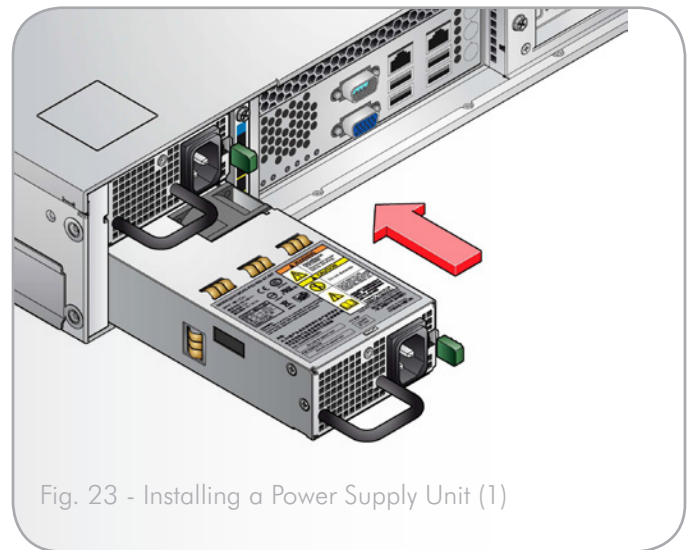


Fig. 23 - Installing a Power Supply Unit (1)

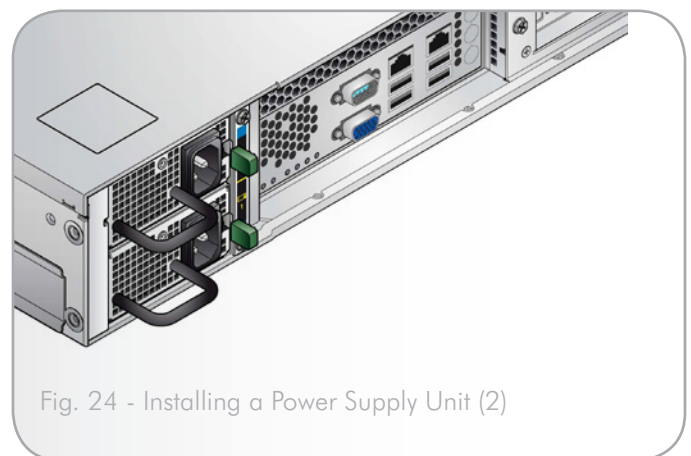


Fig. 24 - Installing a Power Supply Unit (2)

5.3.2. Cooling Fans

The LaCie 12big Rack Network enclosure system incorporates ten cooling fans, housed in a Cooling Cage. Fan modules are individually installed.

IMPORTANT INFO: A faulty Cooling Fan must be replaced by a fully operational Cooling Fan within 72 hours. Do not remove the faulty module until you have a replacement module of the same type available.

5.3.2.1. Removing a Cooling Fan

CAUTION: The enclosure top cover should only be opened by service personnel as it provides access to a service area.

Potential hazards include:

- ◆ Rotating fans
- ◆ Hot surfaces

Upon replacement, the cover **MUST** be secured by turning the lock mechanism to the “locked” position with a screwdriver.

1. To access the ten Cooling Fans, release the enclosure top cover by turning the lock mechanism to the “unlocked” position and slide the cover back until it stops (see [Fig. 25](#)).
2. Grip the faulty Fan module with finger and thumb and pull it upwards in order to unplug it from the Enclosure Management PCB and remove it from the enclosure (see [Fig. 26](#)).

CAUTION: Ensure the fan has stopped rotating before you attempt to remove it. Risk of trapping or cutting fingers.



Fig. 25 - Removing the Enclosure Cover

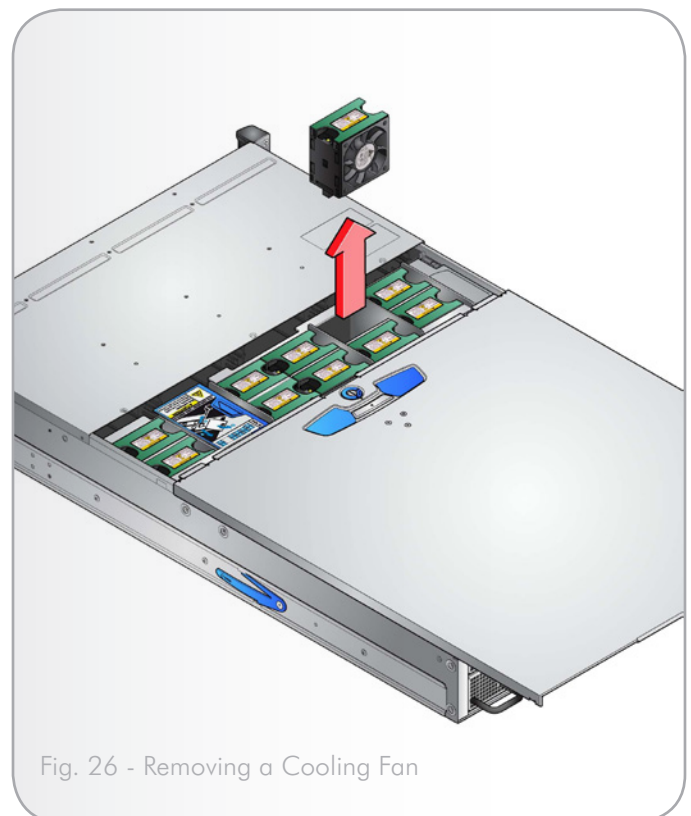


Fig. 26 - Removing a Cooling Fan

5.3.2.2. Installing a Cooling Fan

Parts Check List

- ◆ Cooling Fan module

1. Check the Fan module for damage, do not install if there are any visible signs of damage
2. Grip the Fan module and push it all the way into the enclosure until it fits firmly and is level with the other fans (see Fig. 27). The fan module plugs into the Enclosure Management PCB.
3. Ensure that the Fan module LED extinguishes within 10 seconds of installation.
4. Repeat the above procedure for each fan to be fitted.
5. Close the enclosure cover and secure by turning the lock mechanism to the "locked" position.

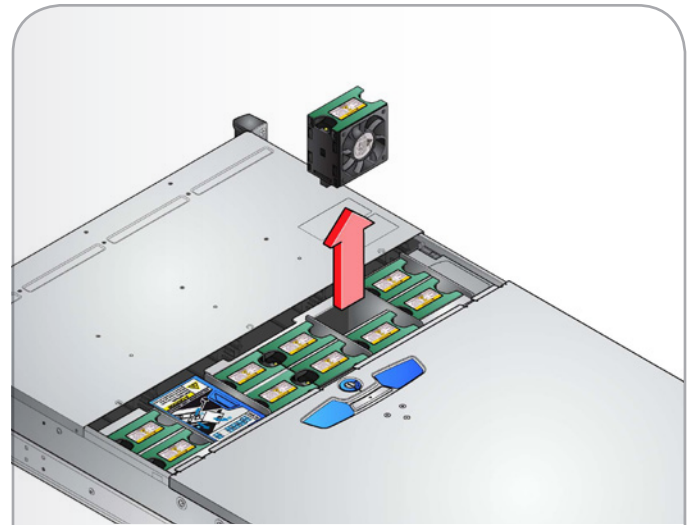


Fig. 27 - Cooling Fan Installation

5.3.3. Drive Carrier Module

CAUTION: Observe all conventional ESD precautions when handling LaCie 12big Rack Network modules and components. Avoid contact with backplane components and module connectors, etc.

5.3.3.1. Removing a Drive Carrier

Drive spin down: Damage can occur to a drive if it is removed while still spinning. If possible use the operating system to spindown the drives prior to removal. If this is not possible we recommend that you perform All steps of the following procedure to ensure that the drive has stopped prior to removal:

1. If the anti-tamper lock has been activated, de-activate by locating the key into its socket and rotating it in an anti-clockwise direction until the indicator is no longer visible in the aperture beside the key.
2. Release the carrier handle, by pressing the latch in the handle towards the handle hinge (i.e. towards the front of the enclosure), see Fig. 28).
3. Gently withdraw the Drive Carrier module approximately 1 inch (25mm), and wait 30 seconds (see Fig. 29).
4. Withdraw the module from the drive bay.

CAUTION: Dummy Drive Carrier modules MUST be fitted to ALL unused drive bays. There will be inadequate drive cooling if any are left open.

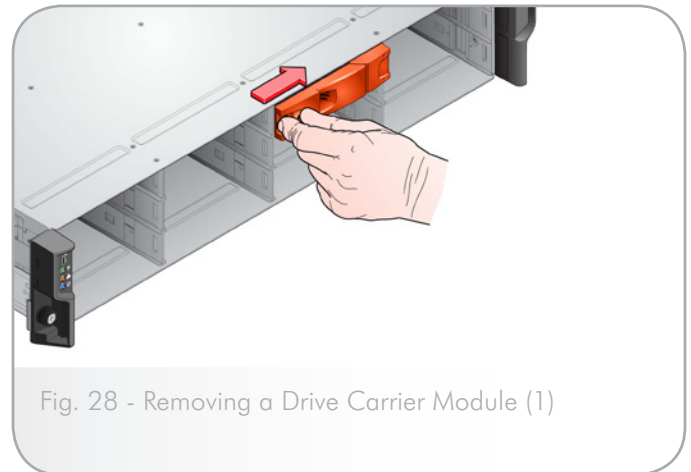


Fig. 28 - Removing a Drive Carrier Module (1)

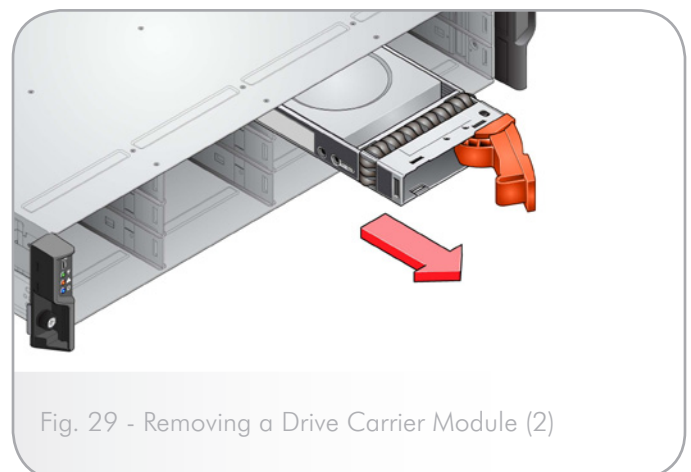


Fig. 29 - Removing a Drive Carrier Module (2)

5.3.3.2. Installing a Drive Carrier

IMPORTANT INFO: A Drive Carrier module cannot be installed if its anti-tamper lock is activated outside the enclosure. Please refer to section 5.3.3.1. *Removing a Drive Carrier* for the de-activation procedure.

Parts Check List

- ◆ Drive Carrier module

1. Release the drive carrier handle, by depressing the latch in the handle (see [Fig. 30](#)).
2. Insert the drive carrier into the enclosure ([Fig. 31](#)).

IMPORTANT INFO: Ensure that the carrier is orientated so that the drive is uppermost and the handle opens from the left, as shown in [Fig. 32](#).

3. Slide the drive carrier, gently, all the way into the enclosure.
4. Cam the drive carrier home - the camming foot on the base of the carrier will engage into a slot in the enclosure. Continue to push firmly until the handle fully engages. A click should be heard as the latch engages and holds the handle closed.

[continued on the next page >>](#)

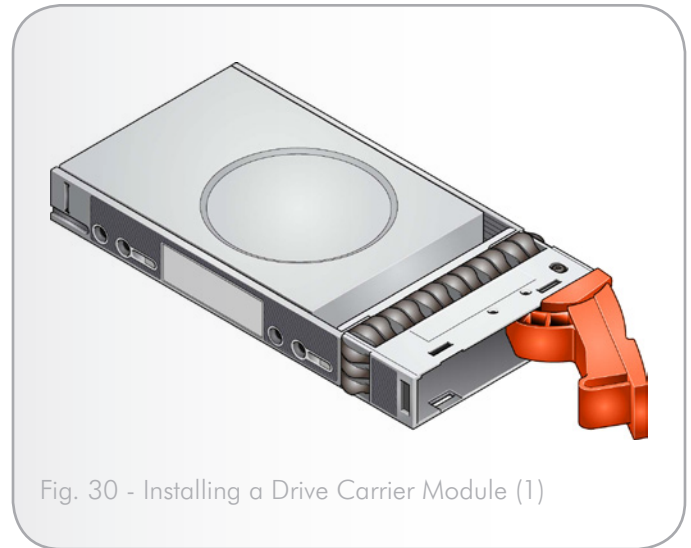


Fig. 30 - Installing a Drive Carrier Module (1)

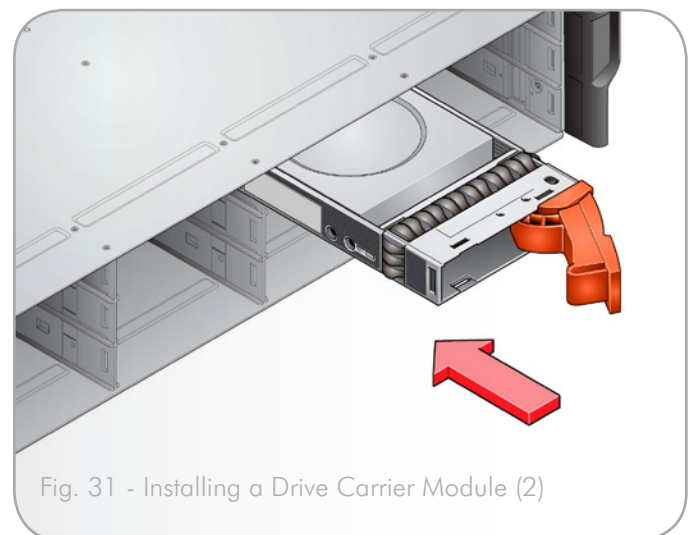


Fig. 31 - Installing a Drive Carrier Module (2)

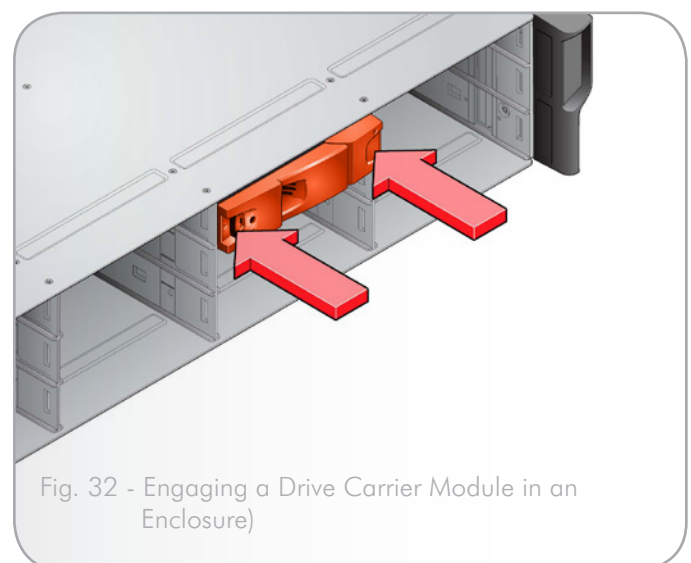


Fig. 32 - Engaging a Drive Carrier Module in an Enclosure)

CAUTION: Ensure that all drive carriers are fully engaged in the enclosure by firmly pushing each one home into the slot, as shown in [Fig. 33](#).

Activating the Anti-tamper Locks

1. Carefully insert the lock key provided into the cutout in the handle.
2. Locate the key into its socket.
3. Rotate the key in a clockwise direction until the indicator is visible in the aperture beside the key.
4. Remove the key.

5.4. Replacing the SAS Expander PCB

CAUTION: Hot Surfaces: Disconnect power and allow to cool before servicing

1. To access the SAS Expander PCB, release the enclosure top cover by turning the lock mechanism to the “unlocked” position and slide the cover back until it stops (see [Fig. 25](#)).
2. Slide the cover forward, lifting at the same time to completely remove the cover.
1. To remove the SAS Expander PCB, open the PCB cover, squeeze the retaining pin and pull the PCB assembly forward, unplugging it from the Backplane and remove the SAS cable.
2. To replace the SAS Expander PCB, squeeze the retaining pin to locate the PCB assembly over it in order to plug the assembly into the Backplane and refit the SAS cable.
3. Close the PCB cover and then close the enclosure cover and secure by turning the lock mechanism to the “locked” position.



Fig. 33 - Drive Carrier Modules Installed in Enclosure

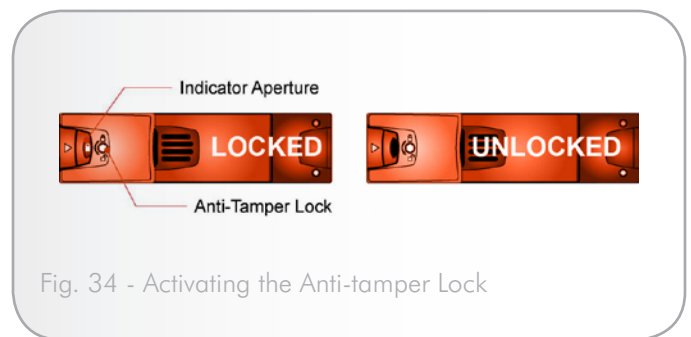


Fig. 34 - Activating the Anti-tamper Lock

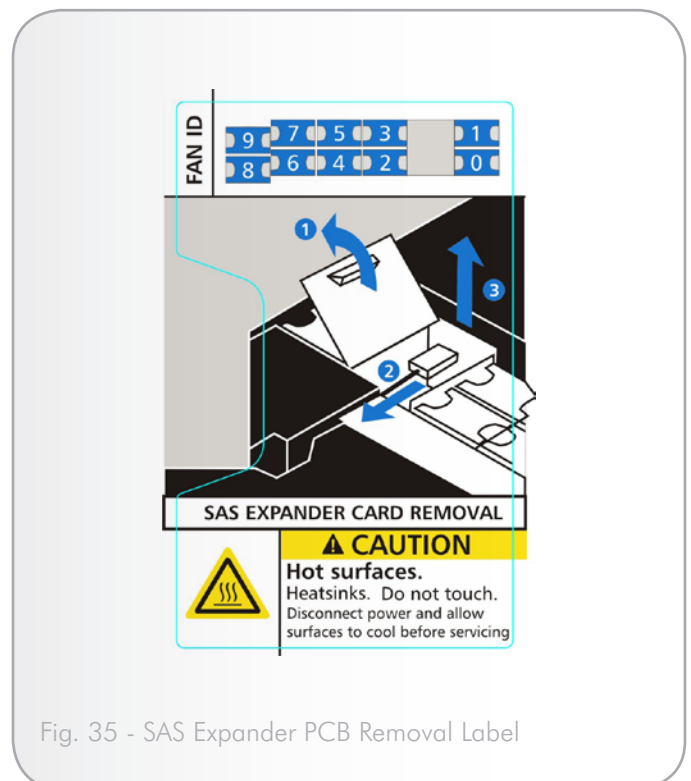


Fig. 35 - SAS Expander PCB Removal Label

5.5. Replacing ATX Motherboards

ATX Motherboard replacement by service personnel is not recommended. Please contact LaCie.

5.5.1. Replacing FB-DIMM Memory Modules

The LaCie 12big Rack Network enclosure system supports up to 32GB of memory. The memory consists of up to 8 FB-DIMM modules that are located in memory slots A1, A2, B1, B2, C1, C2 and D1, D2 on the Motherboard.

When populating the FB-DIMM slots ensure that all FB-DIMMs have the same capacity. The slots should be populated in the following order: A1, B1, C1, D1, A2, B2, C2, D2

After replacing/installing the FB-DIMM memory modules the SDR1 record must be updated to ensure that any new/replacement FB-DIMM modules are identified and recognized by the system.

5.5.2. Replacing a CPU

The LaCie 12big Rack Network enclosure system supports up to 2 Intel CPUs. It includes support for both dual and quad core processor packages.

1. To access the CPU, release the enclosure top cover by turning the lock mechanism to the “unlocked” position and slide the cover back until it stops (see [Fig. 25](#)).
2. Slide the cover forward, lifting at the same time to completely remove the cover.
3. Remove the CPU/memory ducting.
4. Release the 4 screws securing the heatsinks and remove the heatsink.

NOTE: If there are two CPUs to be removed/installed then both heatsinks must be removed.

5. Press and release the spring clip retaining the CPU.
6. Lift up the CPU holding frame and remove the CPU.
7. Fit the new CPU (noting polarization), lower the holding frame and retaining clip.
8. Replace the CPU/memory ducting.
9. Replace the enclosure cover and secure by turning the lock mechanism to the “locked” position.

After removing/installing a CPU the SDR must be updated to ensure that the system correctly identifies and recognizes the CPU configuration.

To update the SDR you will need to boot the system into DOS, and then run the Xyratex SDR update utility. XYSLxx, where xx is the SDR release identifier, currently 46.

5.6. Replacing PCI Cards

1. To access a PCI card, release the enclosure top cover by turning the lock mechanism to the “unlocked position” and slide the cover back until it stops (see [Fig. 25](#)).
2. Slide the cover forward, lifting at the same time to completely remove the cover
3. To remove a PCI card, release the screw in the retaining bracket at the back of the enclosure, disconnect all cables and lift the PCB upwards and out of the enclosure.
4. Replace the PCB, reconnect the cables and close the enclosure cover, securing by turning the lock mechanism to the “locked” position.

NOTE: SDR is the ‘Standard Device Record’ from the IPMI specifications etc.

5.6.1. NVRAM Card

CAUTION: The batteries on the NVRAM card(s) are not replaceable and have a maximum life of 12 months. Therefore the complete card assembly must be replaced annually or in the event of battery failure.

5.7. Blanking Plates

IMPORTANT INFO: Blanking Plates must be fitted in all empty PCI slots.

5.8. Replacing RAID Controller PCI Cards

The RAID Controller PCI is installed in the left hand PCI slot (when viewed from the rear), as shown in [Fig. 19](#).

1. To access the RAID Controller PCB, release the enclosure top cover by turning the lock mechanism to the “unlocked position” and slide the cover back until it stops (see [Fig. 25](#)).
2. Slide the cover forward, lifting at the same time to completely remove the cover
3. To remove the RAID Controller PCB, release the screw in the

retaining bracket at the back of the enclosure, disconnect the BBU/PCM (Portable Cache Module) and SAS cables and lift the PCB upwards and out of the enclosure.

4. Replace the PCB, reconnect the BBU/PCM and SAS cables and close the enclosure cover, securing by turning the lock mechanism to the “locked” position.

5.9. Replacing the Battery Backup Unit

When a RAID Controller PCB is fitted, a battery backup unit may be installed in the right hand PCI slot (when viewed from the rear), as shown in [Fig. 19](#).

CAUTION: Risk of explosion if battery pack is replaced by an incorrect type. The battery pack must only be replaced with a battery pack of the following type, which contains current limiting and temperature sensing devices:

CAUTION: If this equipment is used in a manner not specified by the manufacturer, the protection provided by the equipment may be impaired.

The BBU should only be replaced by a trained technician.

ESD Precautions:

It is recommended that you fit and check a suitable anti-static wrist or ankle strap and observe all conventional ESD precautions when handling plug-in modules and components. Avoid contact with backplane components and module connectors, etc.

CAUTION: The following procedure will remove all data from the cache.

Tools Required: Pozidrive Screwdriver

[continued on the next page >>](#)

To access the Battery Backup Unit:

1. Release the enclosure top cover by turning the lock mechanism to the “unlocked” position pressing the release latch down and sliding the cover back until it stops.
2. Slide the cover forward, lifting at the same time to completely remove the cover.

To remove the Battery Backup Unit:

3. Release the screw in the retaining bracket at the back of the enclosure and ease the BBU out of the PCI slot.
4. Disconnect the BBU cable and remove the BBU from the enclosure.

CAUTION: Support the BBU while releasing the cable and take care not to bend the pins on the BBU card when unplugging the connector

To replace the Battery Backup Unit:

NOTE: Replacement is the reverse of the removal procedure, viz:

5. Reconnect the BBU cable to the BBU.
6. Re-install BBU in PCI slot.
7. Support the BBU while aligning the bracket and replacing the screw removed at step 3.
8. Replace the enclosure cover, securing by turning the lock mechanism to the “locked” position.

IMPORTANT INFO: Dispose of the exhausted battery in accordance with National safety regulations.

5.10. Replacing the Boot Drives

CAUTION: When handling drives, ensure that they are placed (and stored) on a cushioned surface.

You can replace individual boot drives or the complete boot drive module.

CAUTION: Power down and wait 30 seconds for drives to spin down before removal

1. To access the boot drive module, release the enclosure top cover by turning the lock mechanism to the “unlocked” position and slide the cover back until it stops (see Fig. 25).
2. Slide the cover forward, lifting at the same time to completely remove the cover.
3. Remove the CPU/memory ducting.
4. Unscrew the two screws securing the fan ducting and remove the ducting.
5. To remove the module, release the single securing screw at the top of the module and the two screws at the side of the enclosure (see Fig. 36).
6. Lift the module assembly out of the enclosure to access the boot drives.
7. Disconnect the power cord and the data cable(s) from the drive(s).
8. Remove the two screws and spacers from the side of the cage facing the CPU.
9. Slacken the four screws at the top of the cage and unplug the PCB. If two drives are fitted you must also slacken the four at the bottom of the cage as well.
10. To release the boot drive(s), remove the four securing screws completely from the top (and bottom if two drives fitted) of the cage.
11. Fit the new boot drive in the module and retain with the screws removed at step 8 (do not tighten the screws).
12. Plug in the PCB and when the drive(s) and PCB are aligned correctly, tighten the screws inserted at step 11.
13. Reconnect the power and data cables.

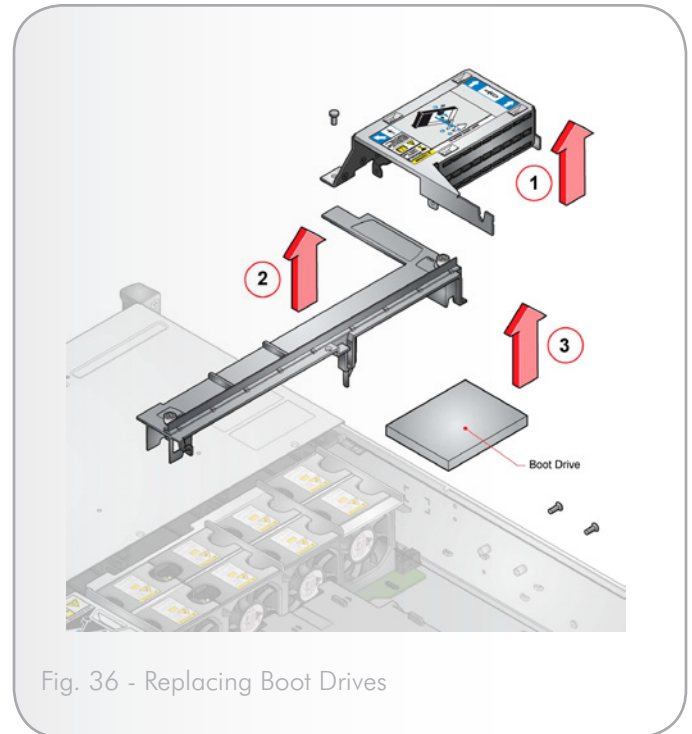


Fig. 36 - Replacing Boot Drives

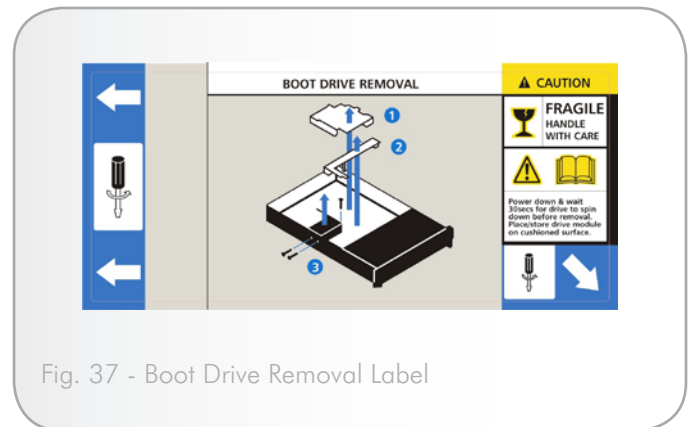


Fig. 37 - Boot Drive Removal Label

continued on the next page >>

14. Relocate the module in the enclosure, securing with the three screws removed at step 5.
 15. Replace the fan ducting, securing with the two screws removed at step 4.
 16. Replace the CPU/memory ducting.
 17. Replace the enclosure cover and secure by turning the lock mechanism to the "locked" position.
-

6. Technical Specifications

6.1. Dimensions

Rack Enclosure	Inches	mm
Height	3.46	87.9
Width across mounting flange	19.01	483
Width across body of enclosure	17.68	449
Depth from rack posts to rear of PCI bulkhead	26.82	681.3
Depth from rack posts to maximum extremity of enclosure	27.83	707
Depth from flange to furthest extremity at front of Ops covers	1.18	30

6.2. Weight

Maximum Configuration	30 kg (66 lb)
Enclosure w/o drives installed	22 kb (48.4 lb)

6.3. Environment

	Temperature Range	Relative Humidity	Max. Wet Bulb
Operational	5°C to 35°C	20% to 80% non-condensing	23°C
Non-Operational	1°C to +50°C	8% to 80% non-condensing	27°C
Storage	1°C to +60°C	5% to 80% non-condensing	29°C
Shipping	-40°C to +60°C	5% to 100% non-precipitating	29°C

Airflow	System must be operated with low pressure rear exhaust installation (Back pressure created by rack doors and obstacles not to exceed 5 pascals [0.5mm Water gauge])
Altitude, Operational	0 to 2133 m (0 to 7,000ft)
Altitude, Non-Operational	-305 to 12,192m (-1000 to 40,000ft)
Shock, Operational	Vertical axis 5g peak 1/2 sine, 10ms

Shock, Non-Operational	20g 10ms 1/2 sine (test w drives) 30g 10ms 1/2 sine (test w/o drives)
Vibration, Operational	0.2grms 5-500 Hz Random
Vibration, Non-Operational	0.8grms 2-200 Hz Random (test w drives) 1.04grms 2-200 Hz Random (test w/o drives)
Vibration, Relocation	0.15g 2-200 Hz sine (test w drives) 0.3g 2-200 Hz sine (test w/o drives)
Acoustics	Sound Power Operating: All fans running at 46%: Less than 58 dB LpA average measured at the bystander positions. (The 4 bystander positions are 1m horizontal and 1.5m off the floor positioned front, back, left and right. The unit under test will be measured on the floor). Measured at 20°C
Orientation & Mounting	19" Rack mount (2EIA Units)
Rack Rails	To fit 800mm depth racks compliant with IEC 297
Rack Characteristics	Back pressure not exceeding 5 pascals (0.5mm water gauge)

6.4. AC Power Module (2 x 850W PSU)

Voltage Range	100-240V AC Rated
Voltage Range Selection	Full Range PSU
Frequency	50/60 Hz
Input Current	12 A
Power Factor Correction	95%@110V full load
Harmonics	Meets EN61000-3-2
Output	+5 V aux: 4A, +12 V: 70A max
Output Rails	6
Dimensions	84mm high x 107mm wide x 371mm Long (3.3in x 4.21in x 1.46in)

6.5. Cooling Fan

Fans	10 X Single Rotor High Speed Axial
	PWM Speed Control in 5 banks of 2
	Hot pluggable Connector: to Enclosure Management PCB
	Individual Tacho outputs for each fan
	Operated from resettable fused 12V from supply rail

6.6. Drive Carrier Module Specification

IMPORTANT INFO: Operating the LaCie 12big Rack Network subsystem with non-approved drives may invalidate the warranty.

Module Dimensions	Height 26.6 mm Width 106.5 mm Depth 220.2 mm
Weight	0.8 kg (1.0" 300GB drive)
Operating Temperature	5° C to 35° C
Power Dissipation	18 Watts maximum

6.7. Drives

6.7.1. Data Drives

- ◆ 3.5" SATA drives

6.7.2. Boot Drives

- ◆ 2 x 2.5" SATA drives

6.8. RAID Card Options

- ◆ RAID Controller PCIe

7. Standards & Regulations

7.1. International Standards

The LaCie 12big Rack Network storage system complies with the requirements of the following agencies and standards:

- ◆ CE to EN 60950-1
- ◆ CB report to IEC 60950-1
- ◆ UL & cUL to UL 60950-1

We, LaCie, solemnly declare that this product conforms to the following European directives: 2004/108/EC (EMC), and 2006/95/EC (Safety)

7.2. Potential for Radio Frequency Interference

USA Federal Communications Commission (FCC)

NOTE: This equipment has been tested and found to comply with the limits for a class A digital device, pursuant to Part 15 of the FCC rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

Properly shielded and grounded cables and connectors must be used in order to meet FCC emission limits. The supplier is not responsible for any radio or television interference caused by using other than recommended cables and connectors or by unauthorized changes or modifications to this equipment. Unauthorized changes or modifications could void the user's authority to operate the equipment.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

7.3. European Regulations

This equipment complies with European Regulations EN 55022 Class A: Limits and Methods of Measurement of Radio Disturbance Characteristics of Information Technology Equipment and EN50082-1: Generic Immunity.

7.4. ESD Precautions

CAUTION: It is recommended that you fit and check a suitable anti-static wrist or ankle strap and observe all conventional ESD precautions when handling LaCie 12big Rack Network plug-in modules and components. Avoid contact with backplane components and module connectors, etc.

7.5. Safety Compliance

System Product Type Approval	UL, cUL, CE
Safety Compliance	UL 60950 IEC 60950 EN 60950

7.6. EMC Compliance

Conducted Emissions Limit Levels	CFR47 Part 15B Class A EN55022 Class A CISPR Class A
Radiated Emissions Limit Levels	CFR47 Part 15B Class A EN55022 Class A CISPR Class A
Harmonics and Flicker	EN61000-3-2/3
Immunity Limit Levels	EN55024

NOTE: The cable must not have a connection to a common ground/earth point.

7.7. AC Power Cords

1. United States

Must be NRTL LISTED (National Recognized Test Laboratory, e.g. UL)

Cord type	SV or SVT, 18 AWG minimum, 3 conductor, 4.5 M max length.
Plug	NEMA 5-15P grounding-type attachment plug rated 120V 10A; or IEC 320 C14, 250V, 10A.
Socket	IEC 320, C-13, 250V, 10A.

2. Europe & Others

General requirements:-

Cord type	Harmonized, H05-VF-3G1.0
Socket	IEC 320, C-13, 250V, 10A.

IMPORTANT INFO: The Plug and the complete power cord assembly must meet the standards appropriate to the country, and must have safety approvals acceptable in that country.

7.8. Recycling of Waste Electrical and Electronic Equipment (WEEE)

At the end of the products life, all scrap/ waste electrical and electronic equipment should be recycled in accordance with National regulations applicable to the handling of hazardous/ toxic electrical and electronic waste materials.

Please contact your supplier/Xyratex for a copy of the Recycling Procedures applicable to your product.

IMPORTANT INFO: Observe all applicable safety precautions, e.g. weight restrictions, handling batteries and lasers etc., detailed in the preceding chapters when dismantling and disposing of this equipment.

8. Rack Kit Reference Drawing

8.1. Rail Kit Installation

Fig. 38 shows the ATX Reduced Rail Kit drawing which is included with the Rack Mounting Rail Kit and provides rail assembly details.

Please contact LaCie for the latest issue of this drawing.

[continued on the next page >>](#)

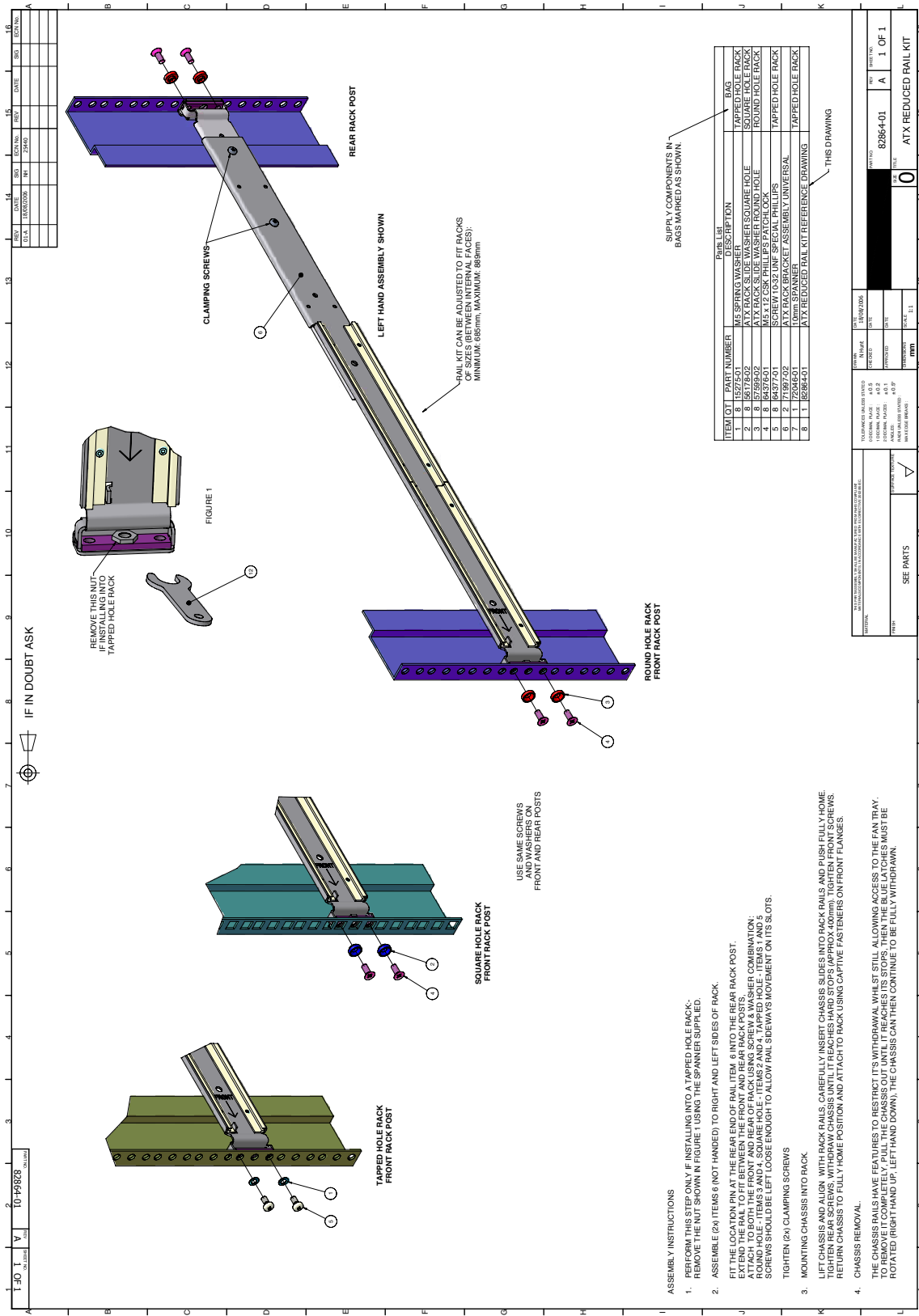


Fig. 38 - Rail Kit Installation Drawing

9. Contacting Customer Support

9.1. LaCie Technical Support Contacts

LaCie Asia Contact us at: http://www.lacie.com/asia/contact/	LaCie Australia Contact us at: http://www.lacie.com/au/contact/
LaCie Belgium Contact us at: http://www.lacie.com/be/contact/ (Français)	LaCie Canada Contact us at: http://www.lacie.com/caen/contact/ (English)
LaCie Denmark Contact us at: http://www.lacie.com/dk/contact	LaCie Finland Contact us at: http://www.lacie.com/fi/contact/
LaCie France Contact us at: http://www.lacie.com/fr/contact/	LaCie Germany Contact us at: http://www.lacie.com/de/contact/
LaCie Italy Contact us at: http://www.lacie.com/it/contact/	Japan – ELECOM CO., LTD. Contact us at: http://www.lacie.com/jp
LaCie Netherlands Contact us at: http://www.lacie.com/nl/contact/	LaCie Norway Contact us at: http://www.lacie.com/no/contact/
LaCie Spain Contact us at: http://www.lacie.com/es/contact/	LaCie Sweden Contact us at: http://www.lacie.com/se/contact
LaCie Switzerland Contact us at: http://www.lacie.com/chfr/contact/ (Français)	LaCie United Kingdom Contact us at: http://www.lacie.com/uk/contact/
LaCie Ireland Contact us at: http://www.lacie.com/ie/contact/	LaCie USA Contact us at: http://www.lacie.com/contact/
LaCie International Contact us at: http://www.lacie.com/intl/contact/	

10. Warranty Information

LaCie warrants your drive against any defect in material and workmanship, under normal use, for the period designated on your warranty certificate. In the event this product is found to be defective within the warranty period, LaCie will, at its option, repair or replace the defective drive. This warranty is void if:

- ◆ The drive was operated/stored in abnormal use or maintenance conditions;
- ◆ The drive is repaired, modified or altered, unless such repair, modification or alteration is expressly authorized in writing by LaCie;
- ◆ The drive was subjected to abuse, neglect, lightning strike, electrical fault, improper packaging or accident;
- ◆ The drive was installed improperly;
- ◆ The serial number of the drive is defaced or missing;
- ◆ The broken part is a replacement part such as a pickup tray, etc.
- ◆ The tamper seal on the drive casing is broken.

LaCie and its suppliers accept no liability for any loss of data during the use of this device, or for any of the problems caused as a result.

LaCie will not, under any circumstances, be liable for direct, special or consequential damages such as, but not limited to, damage or loss of property or equipment, loss of profits or revenues, cost of replacement goods, or expense or inconvenience caused by service interruptions.

Any loss, corruption or destruction of data while using a LaCie drive is the sole responsibility of the user, and under no circumstances will LaCie be held liable for the recovery or restoration of this data.

Under no circumstances will any person be entitled to any sum greater than the purchase price paid for the drive.

To obtain warranty service, call LaCie Technical Support. You will be asked to provide your LaCie product's serial number, and you may be asked to furnish proof of purchase to confirm that the drive is still under warranty.

All drives returned to LaCie must be securely packaged in their original box and shipped with postage prepaid.

IMPORTANT INFO: Register online for free technical support:
www.lacie.com/register
